

# DRUM TRIGGER MODULE DTXPLODER

## SERVICE MANUAL



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## IMPORTANT NOTICE

This manual has been provided for the use of authorized Yamaha Retailers and their service personnel. It has been assumed that basic service procedures inherent to the industry, and more specifically Yamaha Products, are already known and understood by the users, and have therefore not been restated.

**WARNING:** Failure to follow appropriate service and safety procedures when servicing this product may result in personal injury, destruction of expensive components, and failure of the product to perform as specified. For these reasons, we advise all Yamaha product owners that all service required should be performed by an authorized Yamaha Retailer or the appointed service representative.

**IMPORTANT:** The presentation or sale of this manual to any individual or firm does not constitute authorization, certification or recognition of any applicable technical capabilities, or establish a principle-agent relationship of any form.

The data provided is believed to be accurate and applicable to the unit(s) indicated on the cover. The research, engineering, and service departments of Yamaha are continually striving to improve Yamaha products. Modifications are, therefore, inevitable and changes in specification are subject to change without notice or obligation to retrofit. Should any discrepancy appear to exist, please contact the distributor's Service Division.

**WARNING:** Static discharges can destroy expensive components. Discharge any static electricity your body may have accumulated by grounding yourself to the ground bus in the unit (heavy gauge black wires connect to this bus).

**IMPORTANT:** Turn the unit OFF during disassembly and part replacement. Recheck all work before you apply power to the unit.

## LITHIUM BATTERY HANDLING

This product uses a lithium battery for memory back-up.

**WARNING:** Lithium batteries are dangerous because they can be exploded by improper handling. Observe the following precautions when handling or replacing lithium batteries.

- Leave lithium battery replacement to qualified service personnel.
- Always replace with batteries of the same type.
- When installing on the PC board by soldering, solder using the connection terminals provided on the battery cells. Never solder directly to the cells. Perform the soldering as quickly as possible.
- Never reverse the battery polarities when installing.
- Do not short the batteries.
- Do not attempt to recharge these batteries.
- Do not disassemble the batteries.
- Never heat batteries or throw them into fire.

### ADVARSEL!

Lithiumbatteri-Eksplosionsfare ved fejlagtig håndtering. Udskiftning må kun ske med batteri af samme fabrikat og type. Levér det brugte batteri tilbage til leverandoren.

### VARNING

Explosionsfara vid felaktigt batteribyte.

Använd samma batterityp eller en ekvivalent typ som rekommenderas av apparattillverkaren.

Kassera använt batteri enligt fabrikantens instruktion.

### VAROITUS

Paristo voi räjähtää, jos se on virheellisesti asennettu.

Vaihda paristo ainoastaan laitevalmistajan suosittelemaan tyyppiin.

Hävitätä käytetty paristo valmistajan ohjeiden mukaisesti.

The following information complies with Dutch Official Gazette 1995. 45; ESSENTIALS OF ORDER ON THE COLLECTION OF BATTERIES.

- Please refer to the disassembly procedure for the removal of Back-up Battery.
- Leest u voor het verwijderen van de backup batterij deze beschrijving.

## WARNING: CHEMICAL CONTENT NOTICE!


The solder used in the production of this product contains LEAD. In addition, other electrical/electronic and /or plastic (where applicable) components may also contain traces of chemicals found by the California Health and Welfare Agency (and possibly other entities) to cause cancer and/or birth defects or other reproductive harm.

**DO NOT PLACE SOLDER, ELECTRICAL/ELECTRONIC OR PLASTIC COMPONENTS IN YOUR MOUTH FOR ANY REASON WHATSOEVER!**


Avoid prolonged, unprotected contact between solder and your skin! When soldering, do not inhale solder fumes or expose eyes to solder/flux vapor!

If you come in contact with solder or components located inside the enclosure of this product, wash your hands before handling food.

### ■ WARNING

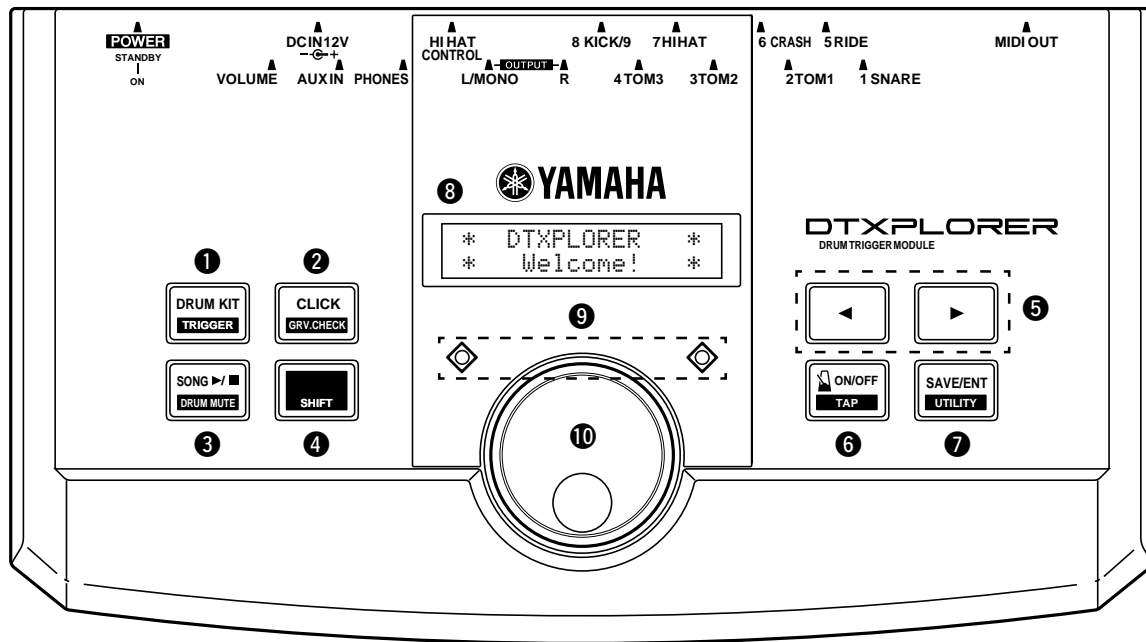
Components having special characteristics are marked  and must be replaced with parts having specification equal to those originally installed.

## ■ SPECIFICATIONS

<b>Tone Generator</b>	16 bit AWM2
<b>Maximum polyphony</b>	32
<b>Voices</b>	192 drum, percussion voices
<b>Drum kits</b>	32 Preset 10 User memory locations
<b>Trigger setups</b>	4 Preset 1 User memory location
<b>Sequencer tracks</b>	1
<b>Other Sequencer Functions</b>	Mute (rhythm mute), Bass Solo, Groove Check
<b>Song</b>	22 Preset (2 Demo Songs, 20 Pattern Songs)
<b>Controls</b>	
Buttons	DRUMKIT, CLICK, SONG, ►/■, SHIFT, ◀, ▶,  ON/OFF, SAVE/ENT
Controllers	VOLUME, Jog Dial
<b>Display</b>	16 x 2 LCD display (w/Back light)
<b>Connections</b>	MIDI OUT HI HAT CONTROLLER (stereo phone jack) OUTPUT L/MONO (mono phone jack) OUTPUT R (mono phone jack) PHONES (stereo phone jack) AUX IN (stereo mini jack) Trigger Inputs 1, 5, 6 (stereo phone jack L : trigger input, R : rim switch) Trigger Inputs 2, 3, 4, 7 (mono phone jack : trigger input) Trigger Input 8/9 (stereo phone jack L, R : trigger input)
<b>Power supply</b>	DC 12V/AC adaptor (PA-3C)
<b>Power Requirement</b>	3.2 Watt
<b>Dimensions (W x D x H)</b>	252 x 140 x 54 mm (9-15/16" x 5-1/2" x 2-1/8")
<b>Weight</b>	835 g (1 lbs. 13 oz.)
<b>Accessories</b>	Owner's Manual AC adaptor

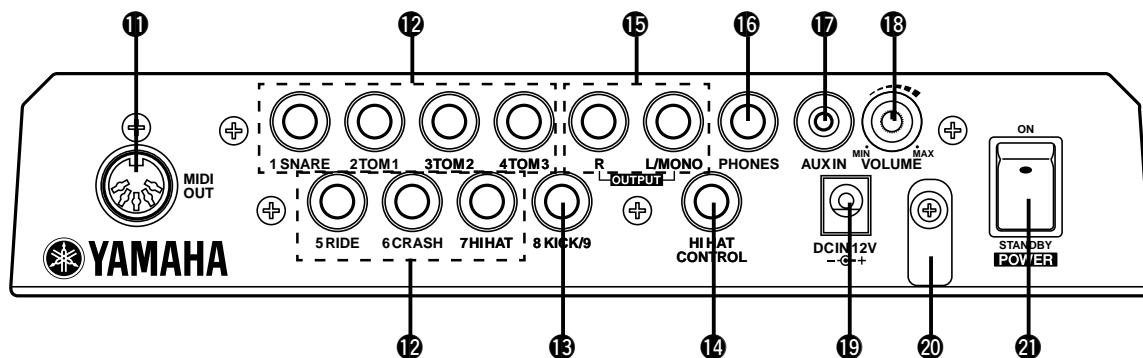
## ■ PANEL LAYOUT

### • Top Panel



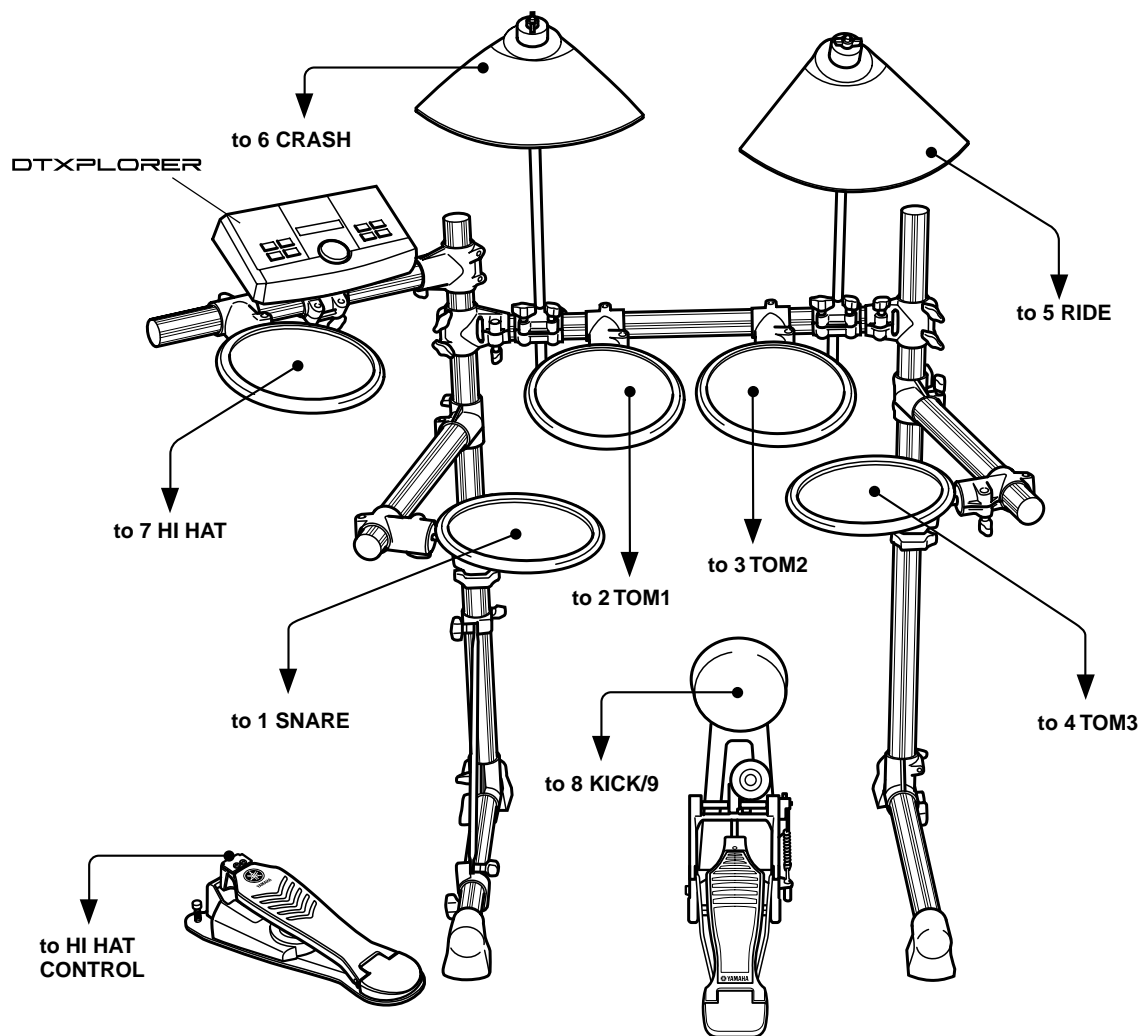
- |   |   |
|---|---|
| <ul style="list-style-type: none"> <li>❶ Drum Kit Button (DRUM KIT)</li> <li>❷ Click Button (CLICK)</li> <li>❸ Song Button (SONG ▶/■)</li> <li>❹ Shift Button (SHIFT)</li> <li>❺ Select Buttons (◀, ▶)</li> </ul> | <ul style="list-style-type: none"> <li>❻ Metronome ON/OFF Button (ON/OFF)</li> <li>❼ Save/Enter Button (SAVE/ENT)</li> <li>❽ LCD Display</li> <li>❾ Click Lamp</li> <li>❿ Jog Dial</li> </ul> |
|---|---|

### • Rear Panel



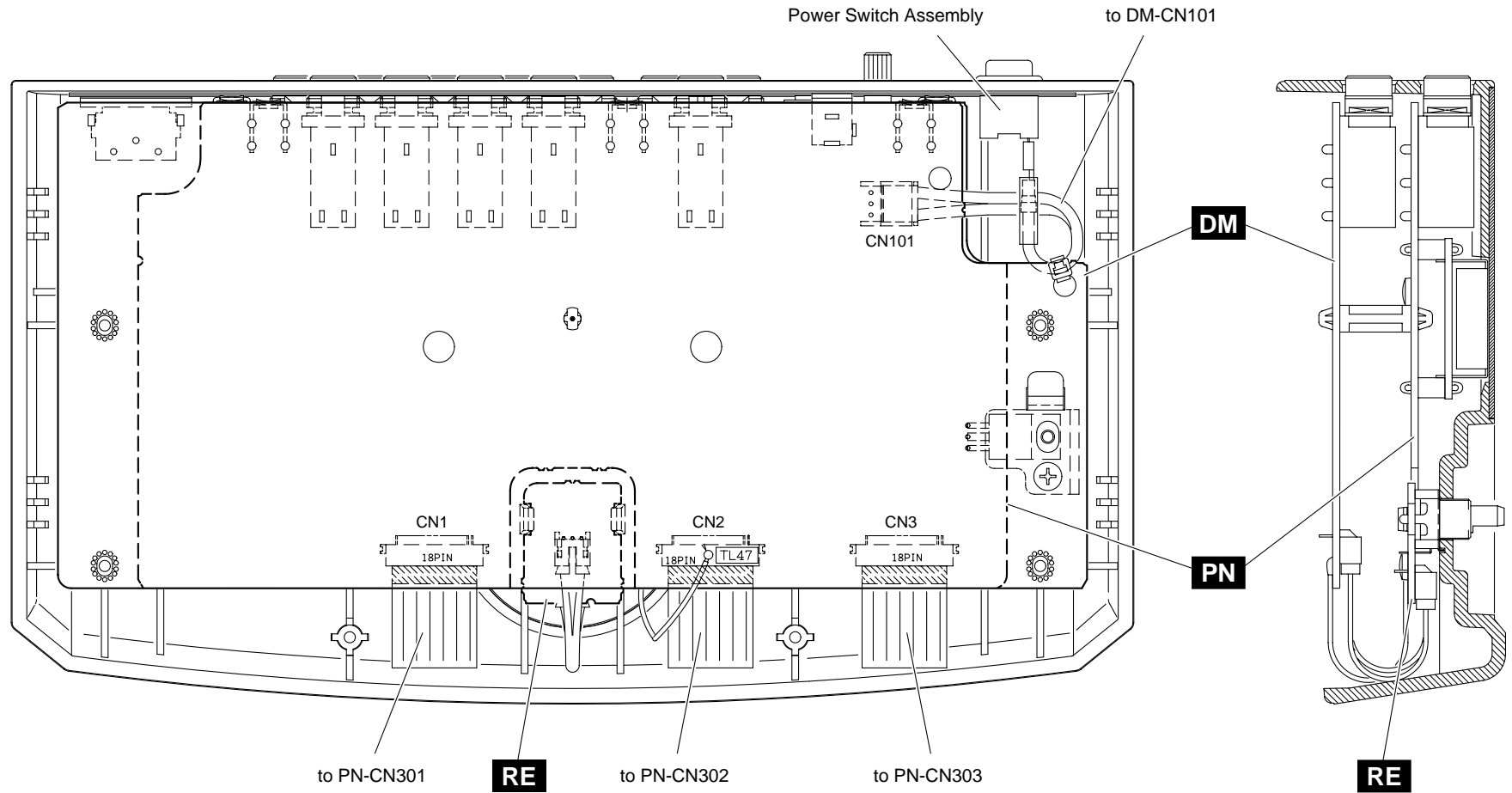
- |   |   |
|---|---|
| <ul style="list-style-type: none"> <li>❶ MIDI OUT Jack</li> <li>❷ Trigger Input Jacks (1 SNARE thru 7 HI HAT)</li> <li>❸ Trigger Input jack (8 KICK/9)</li> <li>❹ Hi-Hat Controller Jack (HI HAT CONTROL)</li> <li>❺ Output Jacks (OUTPUT L/MONO, R)</li> <li>❻ Head Phone Jack (PHONES)</li> </ul> | <ul style="list-style-type: none"> <li>❼ AUX IN Jack</li> <li>❽ Master Volume (VOLUME)</li> <li>❹ Power Supply Jack (DC IN 12V)</li> <li>❺ Cord Hook</li> <li>❻ Power Switch (POWER)</li> </ul> |
|---|---|

## ■ CONNECTING THE PADS

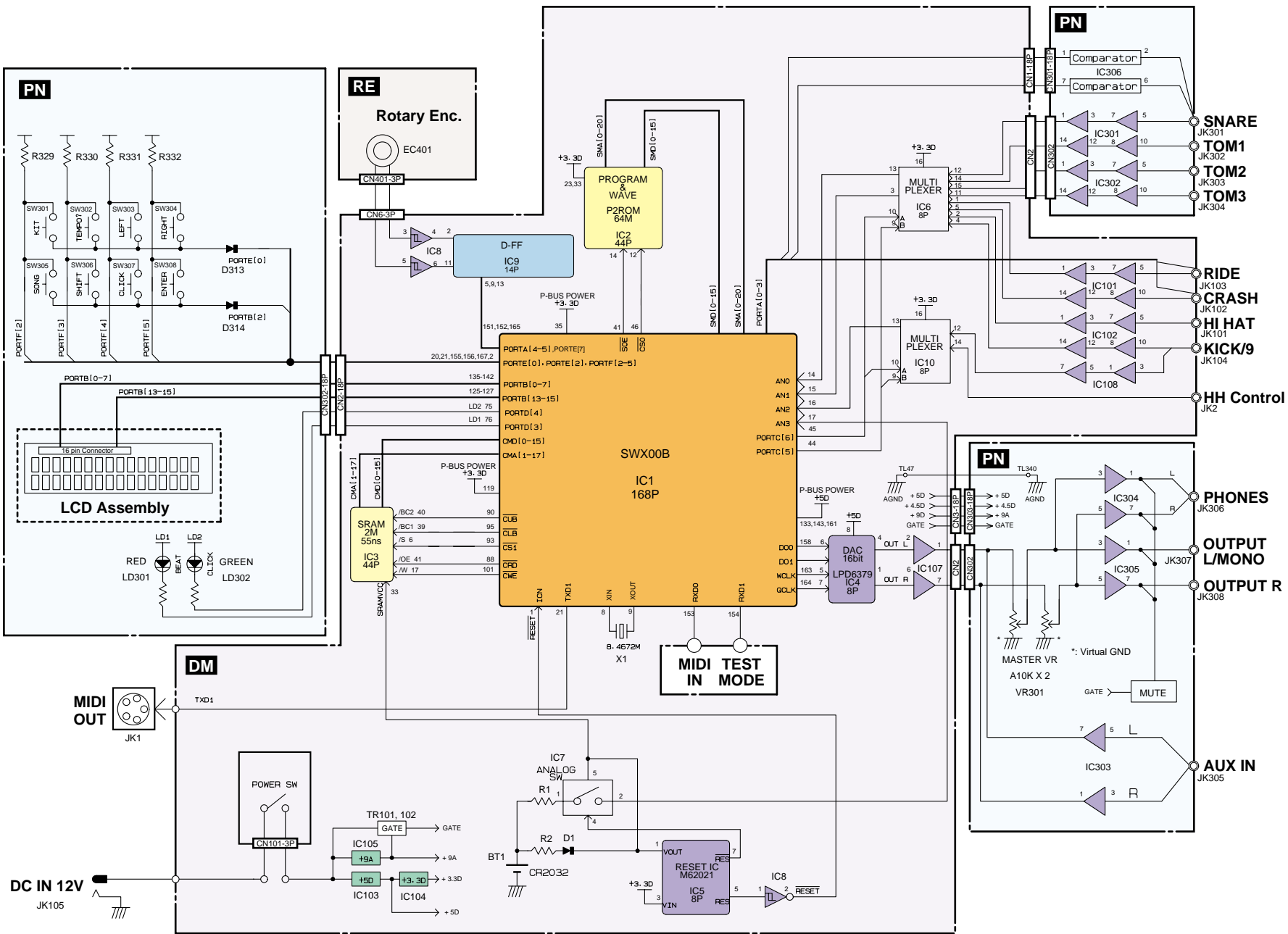


UNIT LAYOUT and WIRING

• Inside View



■ BLOCK DIAGRAM



## ■ DISASSEMBLY PROCEDURE

### 1. Bottom Case Assembly

(time required: about 1 minutes)

- 1-1 Remove the eight (8) screws marked [30a] and the screw marked [50]. The bottom case assembly can then be removed. (Fig. 1)

### 2. DM Circuit board

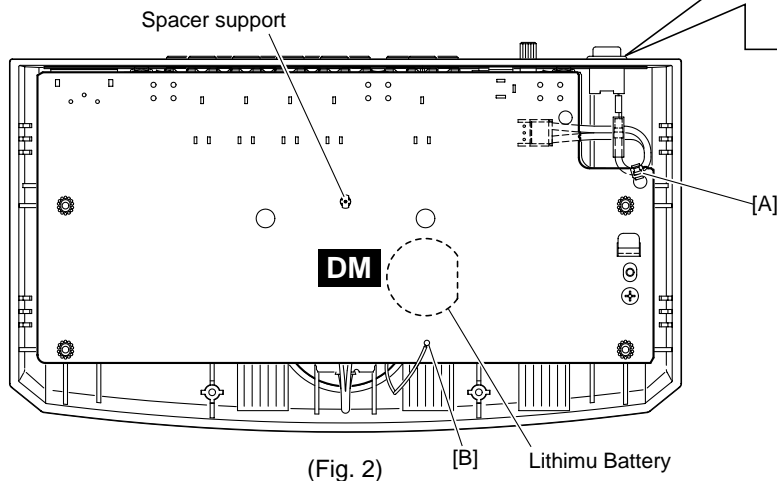
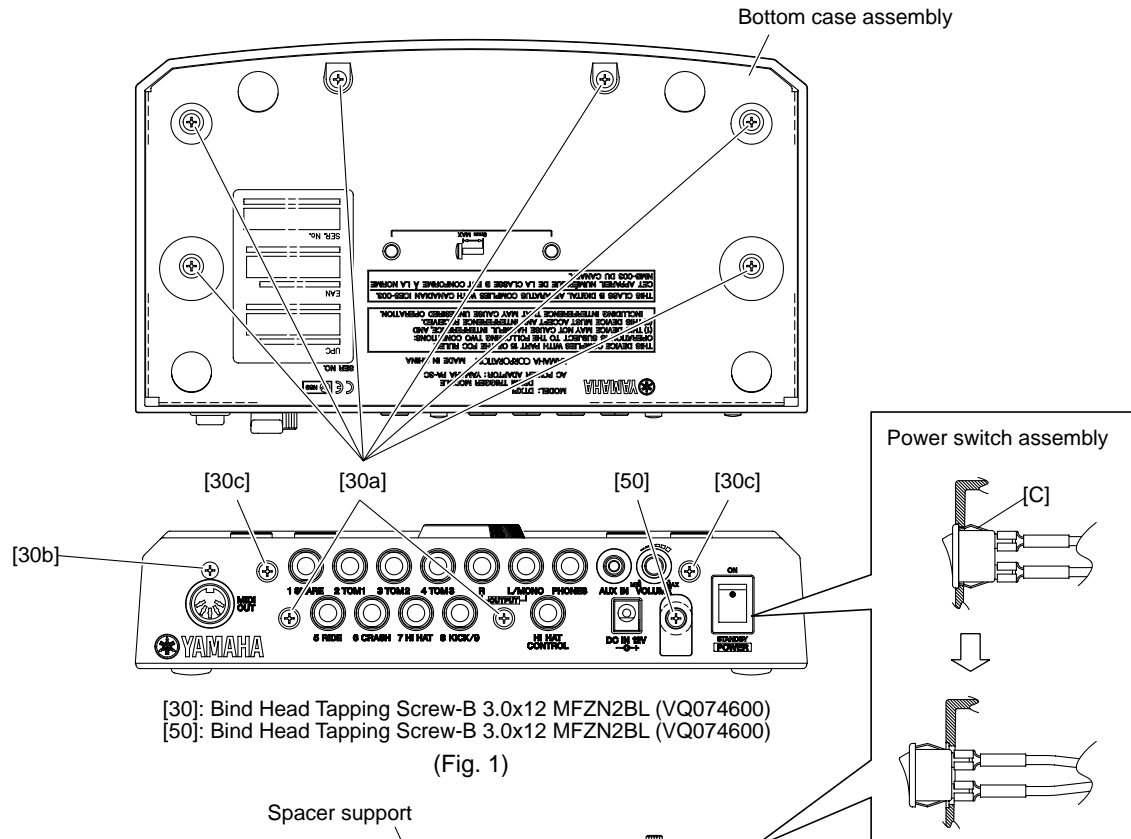
(time required: about 2 minutes)

- 2-1 Remove the bottom case. (See Procedure 1.)  
 2-2 Remove the screw marked [30b] and the spacer support. The DM circuit board can then be removed. (Fig. 1 & 2)  
 \* To remove the DM circuit board, remove the cord holder marked [A] and the solder marked [B].  
 \* When reinstalling the bottom case assembly and DM circuit board, first install the screw marked [30b].

### 3. Power Switch Assembly

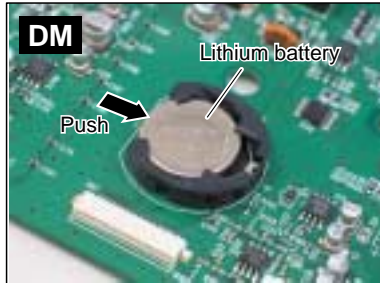
(time required: about 1 minutes)

- 3-1 Remove the bottom case assembly. (See Procedure 1.)  
 3-2 Remove the DM circuit board. (See Procedure 2.)  
 \* Remove the power switch assembly while holding down the stopper marked [C].

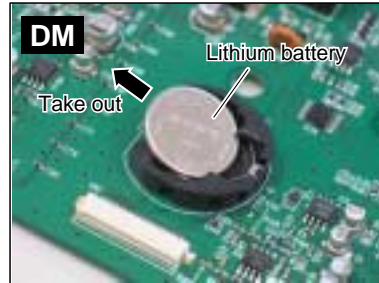




• Battery VN103500 (CR2032)  
 Notice for back-up battery removal  
 Push the battery as shows in photo 1 & 2, then the battery will pop up.



(Photo 1)



(Photo 2)

**4. RE Circuit Board Assembly**

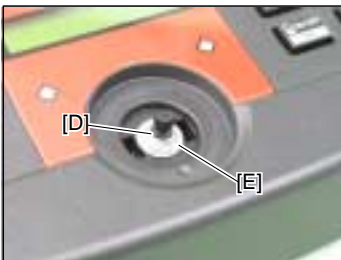
(time required: about 2 minutes)

- 4-1 Remove the bottom case assembly. (See Procedure 1.)
- 4-2 Remove the DM circuit board. (See Procedure 2.)
- 4-3 Remove the jog dial, the nut marked [D] and the washer marked [E].

Then expand the hook marked [F] and remove the RE circuit board. (Fig. 3)(Photo 3 & 4)



(Photo 3)



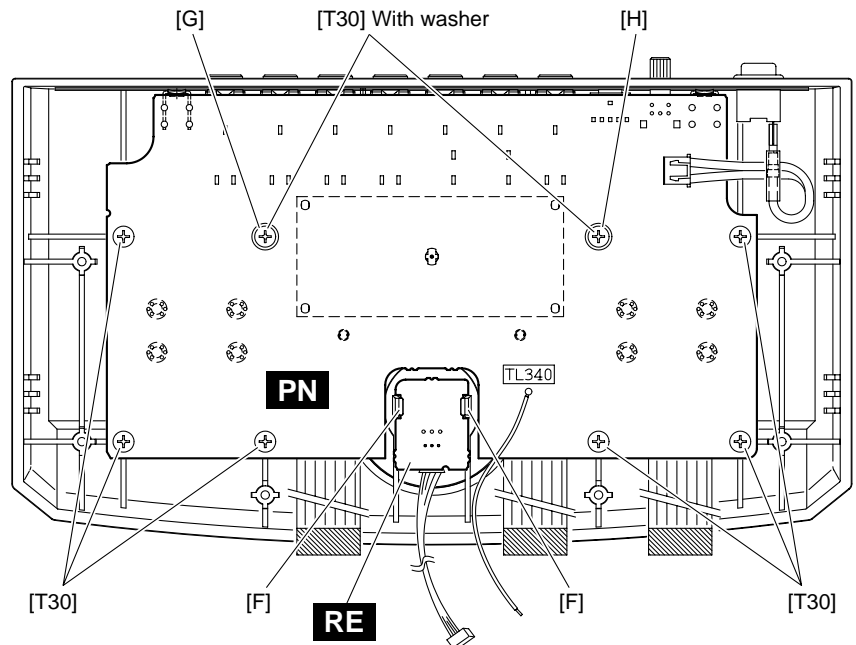
(Photo 4)

**5. PN Circuit Board Assembly**

(time required: about 3 minutes)

- 5-1 Remove the bottom case assembly. (See Procedure 1.)
- 5-2 Remove the DM circuit board. (See Procedure 2.)
- 5-3 Remove the two (2) screws marked [30c], the eight (8) screws marked [T30]. The PN circuit board assembly can then be removed. (Fig. 1 & 3)

- \* Use some force to remove the PN circuit board after removing the screws from the PN circuit board.
- \* In order to reinstall the PN circuit board, use first the screw marked [G] and then the screw marked [H]. (Fig. 3)



[30]: Bind Head Tapping Screw-B 3.0x12 MFZN2BL (VQ074600)  
 [T30]: Bind Head Tapping Screw-B 3.0x8 MFZN2BL (EP600190)

(Fig. 3)

# LSI PIN DESCRIPTION

## ● HG73C205AFD (XU947C00) SWX00B TONE GENERATOR

DM: IC1

PIN No.	NAME	I/O	FUNCTION	PIN No.	NAME	I/O	FUNCTION	
1	ICN	I	Initial clear	85	CMA3	O	} read signal	
2	RFCLKI	I	PLL Clock	86	CMA8	O		
3	TM2	I	PLL Control	87	CMA2	O		
4	AVDD_PLL		Power supply	88	CRD	O		
5	AVSS_PLL		Ground	89	CMA1	O		
6	MODE0	I	SWX dual mode	90	CUB	O		
7	VCC7		Power supply	91	VCC91			
8	GND8		Ground	92	GHND92			
9	XIN	I	crystal oscillator	93	CS1	O		
10	XOUT	O	crystal oscillator	94	CMA0	O		
11	MODE1	I	SWX separate mode	95	CLB	O	high byte effective signal	
12	TEST0	I	TEST pin	96	CMA12	O	low byte effective signal	
13	TESTON	I	TEST pin	97	CMA11	O	} Program address bus	
14	AN0-P40	I	} A/D converter	98	CMA10	O		
15	AN1-P41	I						
16	AN2-P42	I						
17	AN3-P43	I						
18	AVDD_AN		Power supply	100	GND100		Ground	
19	AVSS_AN		Ground	101	CWE	O	write signal	
20	TXD0	O	for MIDI or TO-HOST	102	CMA16	O	} Program address bus	
21	TXD1	O	for MIDI	103	CMA15	O		
22	EXCLK	I	Crystal oscillator	104	CMA14	O		
23	SMD11	I/O	} Wave memory data bus	105	CMA13	O		
24	SMD4	I/O						
25	SMD3	I/O						
26	SMD12	I/O						
27	SMD10	I/O						
28	SMD5	I/O						
29	SMD2	I/O						
30	SMD13	I/O						
31	SMD9	I/O						
32	SMD6	I/O						
33	SMD1	I/O	} Power supply	106	CMD8	I/O		
34	SMD14	I/O		} Ground	107	CMD7	I/O	
35	VCC35		} Power supply		108	CMD9	I/O	
36	GND36			} Ground	109	CMD6	I/O	
37	SMD8	I/O	} Wave memory data bus		110	CMD10	I/O	
38	SMD7	I/O						
39	SMD0	I/O						
40	SMD15	I/O						
41	SOE	O						
42	SWE	O						
43	SRAS	O						
44	SCAS	O						
45	REFRESH	O						
46	CS0	O		} SWX access data bus	111	CMD5	I/O	
47	SMA0	O						
48	SMA16	O						
49	VCC49							
50	GND50							
51	SMA1	O						
52	SMA15	O						
53	SMA2	O						
54	SMA14	O						
55	SMA3	O						
56	SMA13	O	} Memory address bus	112	CMD11	I/O		
57	SMA4	O						
58	SMA12	O						
59	SMA5	O						
60	GND60							
61	VCC61							
62	SMA11	O						
63	SMA6	O						
64	SMA10	O						
65	SMA7	O						
66	SMA9	O	} Memory address bus	113	CMD4	I/O		
67	SMA17	O						
68	SMA8	O						
69	SMA18	O						
70	SMA19	O						
71	SMA20	O						
72	SMA21	O						
73	SMA22	O						
74	SMA23	O						
75	CMA20	O		} Program address bus	114	CMD12	I/O	
76	CMA19	O	} Program address bus		115	CMD3	I/O	
77	VCC77			} Power supply	116	CMD13	I/O	
78	GND78		} Ground		117	CMD2	I/O	
79	CMA18	O		} Program address bus	118	CMD14	I/O	
80	CMA17	O						
81	CMA5	O						
82	CMA6	O						
83	CMA4	O						
84	CMA7	O						
					119	VCC119		Power supply
					120	GND115		Ground
					121	CMD1	I/O	} Program address bus
					122	CMD15	I/O	
				123	CMD0	I/O		
				124	CMA21	O		
				125	PDT15	I/O		
				126	PDT14	I/O		
				127	PDT13	I/O		
				128	PDT12	I/O		
				129	PDT11	I/O		
				130	PDT10	I/O		
				131	PDT9	I/O		
				132	PDT8	I/O		
				133	VCC133		Power supply	
				134	GND134		Ground	
				135	PDT7	I/O	} SWX access data bus	
				136	PDT6	I/O		
				137	PDT5	I/O		
				138	PDT4	I/O		
				139	PDT3	I/O		
				140	PDT2	I/O		
				141	PDT1	I/O		
				142	PDT0	I/O		
				143	VCA143			
				144	GND144			
				145	PAD2	I	} SWX access address bus	
				146	PAD1	I		
				147	PAD0	I		
				148	VCC148		Power supply	
				149	GND149		Ground	
				150	PCS	I	Chip select	
				151	PWR	I	write enable	
				152	PRD	I	read enable	
				153	RXD0	I	for Midi or TO-HOST	
				154	RXD1	I	for Midi or Key scan	
				155	SCLKI	I	EXT Clock	
				156	ADIN	I	A/D converter	
				157	ADLR	O	A/D converter LR clock	
				158	DO0	O	DAC	
				159	DO1	O	DAC	
				160	SYSCLK	O	1/2 clock	
				161	VCC161		Power supply	
				162	GND162		Ground	
				163	WCLK	O	for DAC LR clock	
				164	QCLK	O	1/12 clock	
				165	BCLK	O	IIS-DAC clock	
				166	SYI	I	Synch signal	
				167	IRQ0	I	Interrupt request	
				168	NMI	I	Interrupt request	

• **UPD6379A** (XR998A00) **DAC** (Digital to Analog Converter)

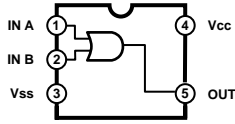
DM: IC4

PIN No.	NAME	I/O	FUNCTION	PIN No.	NAME	I/O	FUNCTION
1	ROUT	O	Rch analog output	5	LRCK	I	L/R Clock
2	REF		Voltage reference	6	SI	I	Serial data input
3	Vss		Ground	7	CLK	I	Shift clock
4	LOUT	O	Lch analog output	8	Vdd		Power supply +5A

## IC BLOCK DIAGRAM

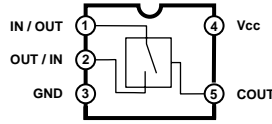
- **TC7S32F** (XM588A00)  
OR

DM: IC12



- **TC7S66FU** (XR867A00)  
Analog Switch

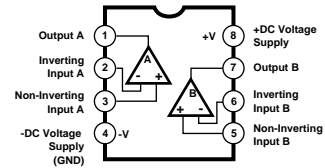
DM: IC7



- **NJM2903M-TE1** (X5814A00)
- **NJM2904M** (XV190A00)
- **NJM4556AM-TE1** (X5049A00)
- **UPC4570GG2** (XF291A00)

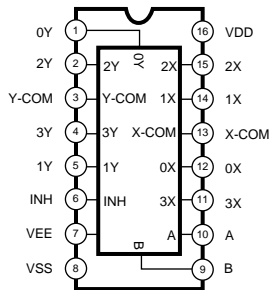
Dual Operational Amplifier

DM: IC106, 107, 108  
PN: IC303, 304, 305, 306



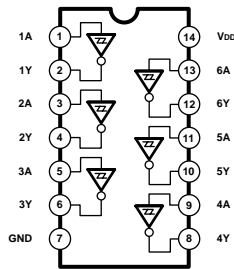
- **TC74HC4052AFT** (XV869A00)  
Differential 4-Channel  
Multiplexer/Demultiplexer

DM: IC6, 10



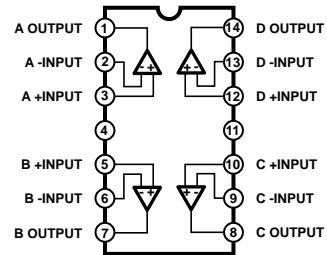
- **SN74HC14PWR** (XZ288A00)  
Hex Inverter

DM: IC8



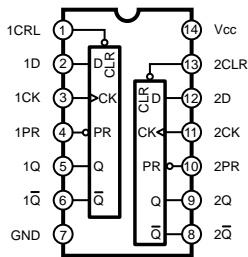
- **NJM2902M-TE1** (X4983A00)  
Quad Operational Amplifier

DM: IC101, 102  
PN: IC301, 302



- **74HC74DT** (X2171A00)  
Dual D-Type Flip-Flop

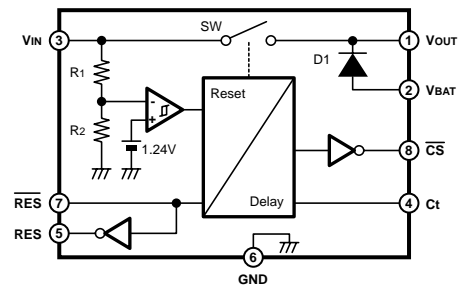
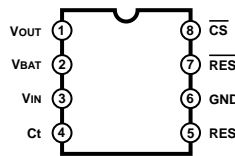
DM: IC9



INPUTS				OUTPUTS	
PR	CLR	CLK	D	Q	Q
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H	H
L	L	X	X	H	H
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q.	Q.

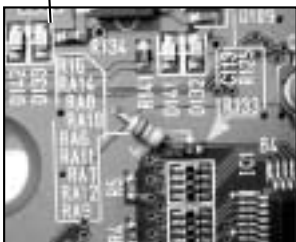
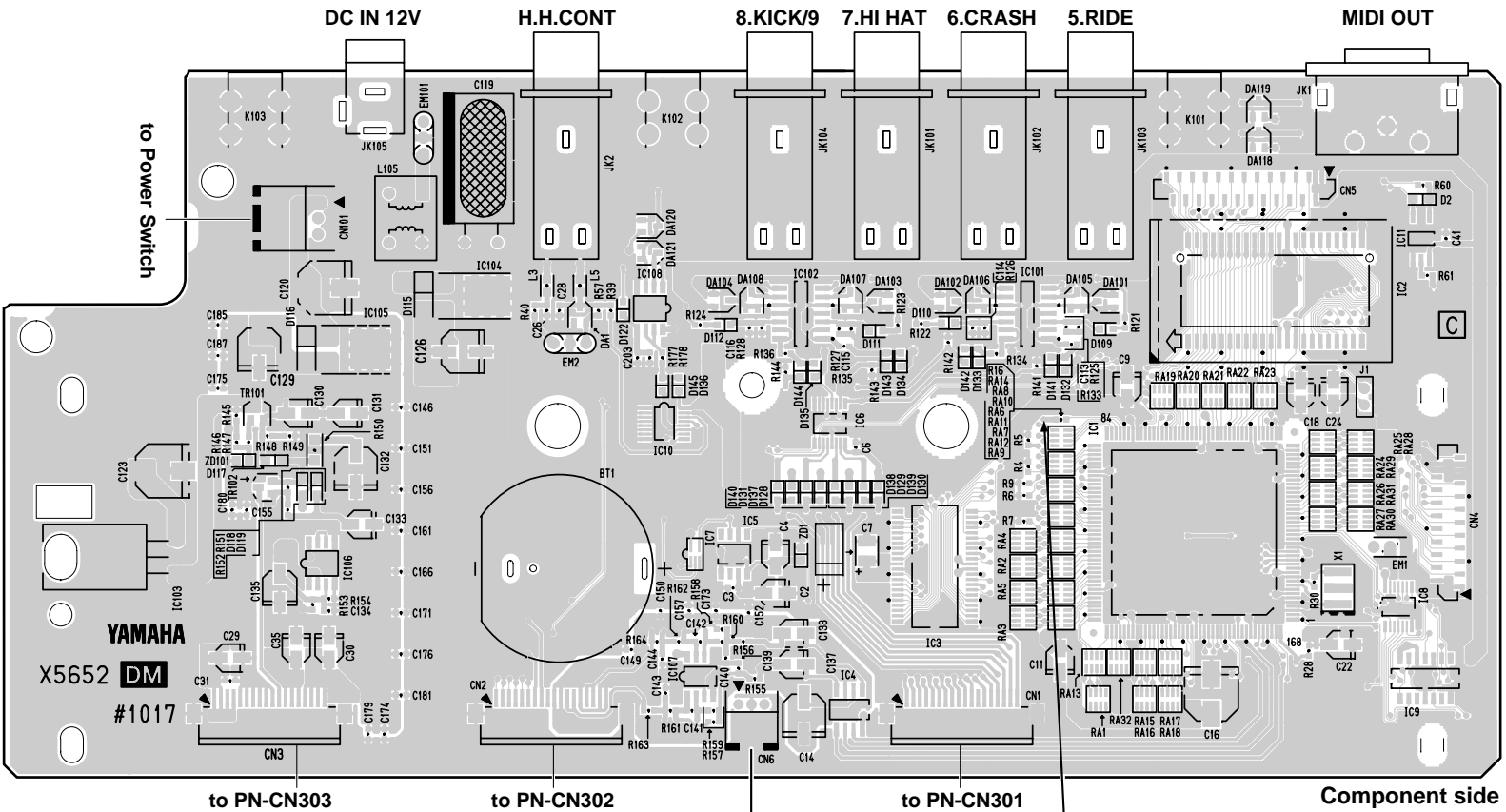
- **M62023FP** (X2163A00)  
System Reset

DM: IC5

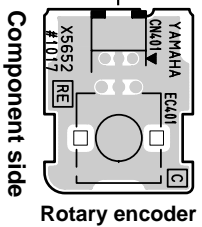


■ **CIRCUIT BOARDS**

● **DM Circuit Board (Version C)**

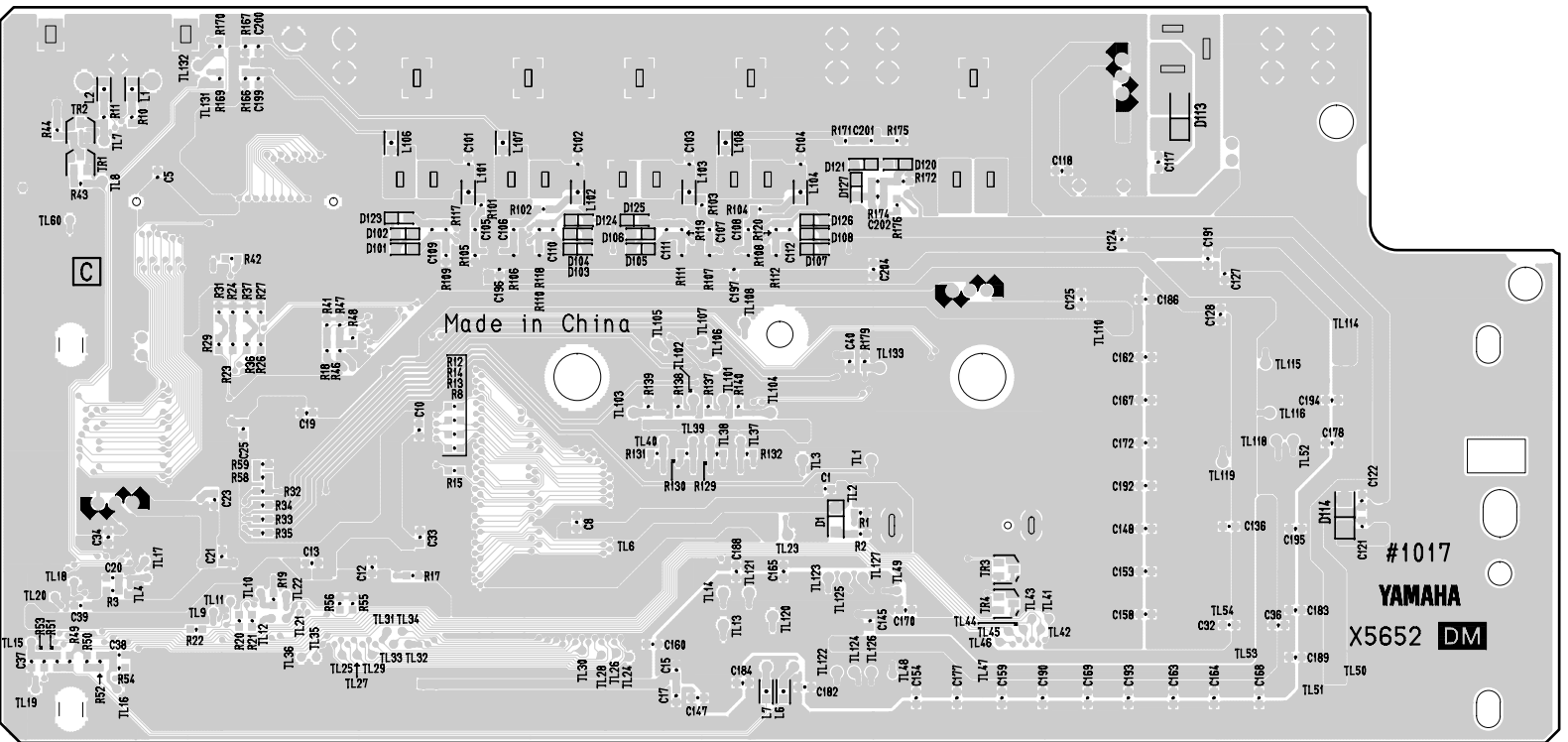


● **RE Circuit Board**  
(Same as for version D)



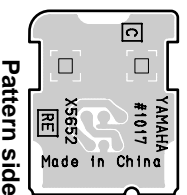
1. Add a resistor (V973290: RES CARBON FILM 1.0K 1/8W) between R16 and a through hole of DGND referring to pic.1&2. Confirm that one leg of the resistor pierce to the through hole.
2. Check the value of resistance between the point indicated by arrow and DGND. Confirm the value is about 1.1k ohm. (Refer to pic.2)

● DM Circuit Board (Version C)



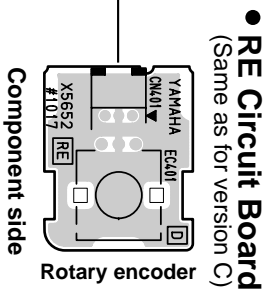
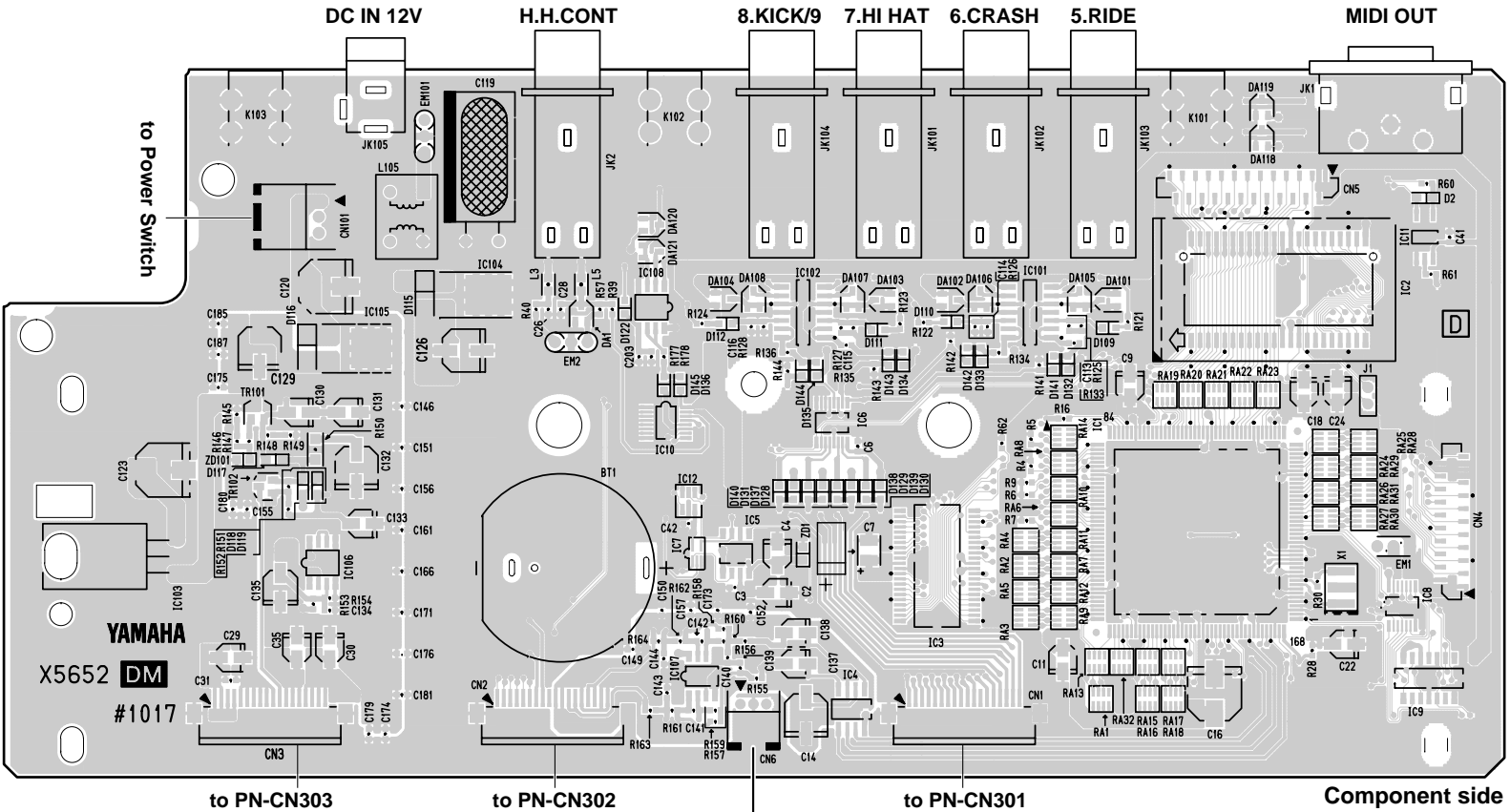
Pattern side

● RE Circuit Board  
(Same as for version D)

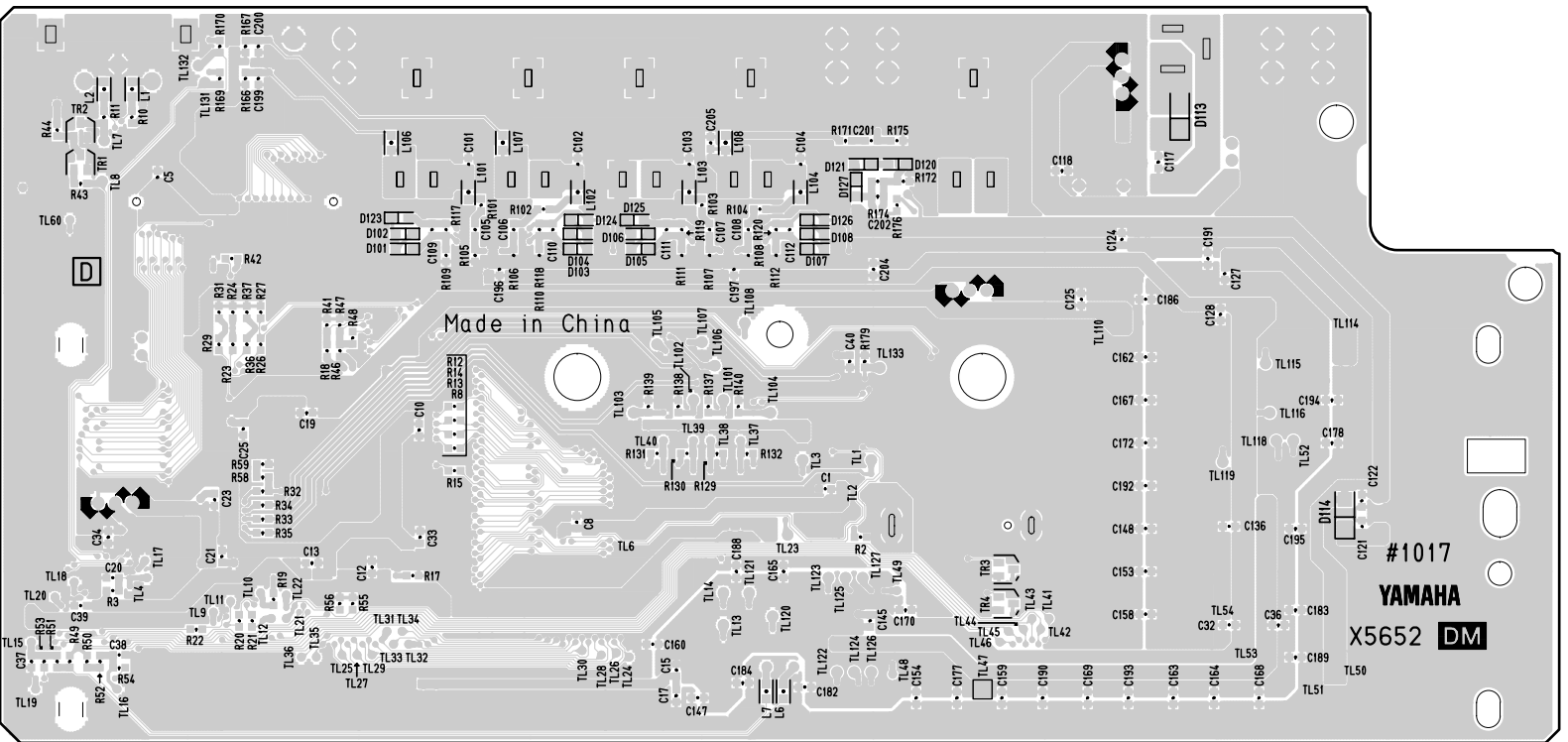


Pattern side

● DM Circuit Board (Version D)

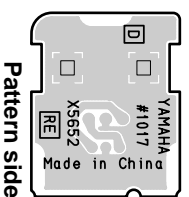


● DM Circuit Board (Version D)



Pattern side

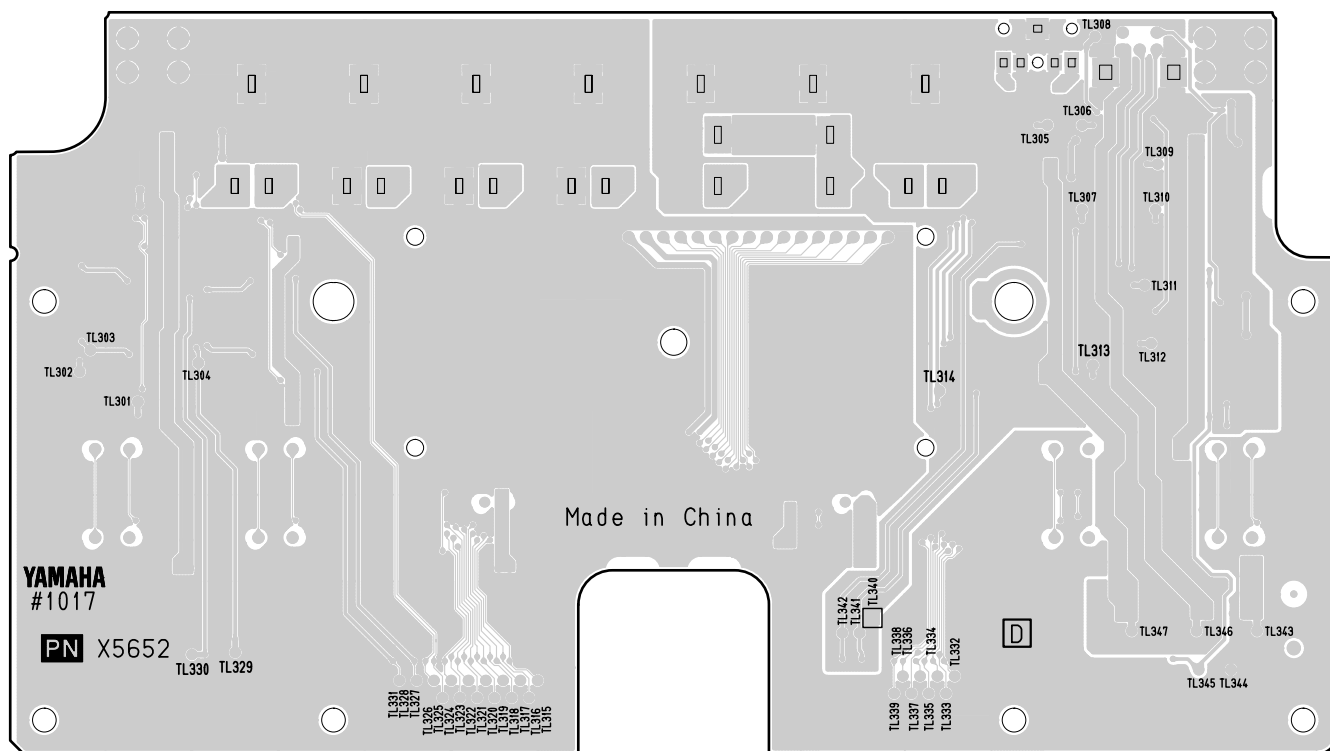
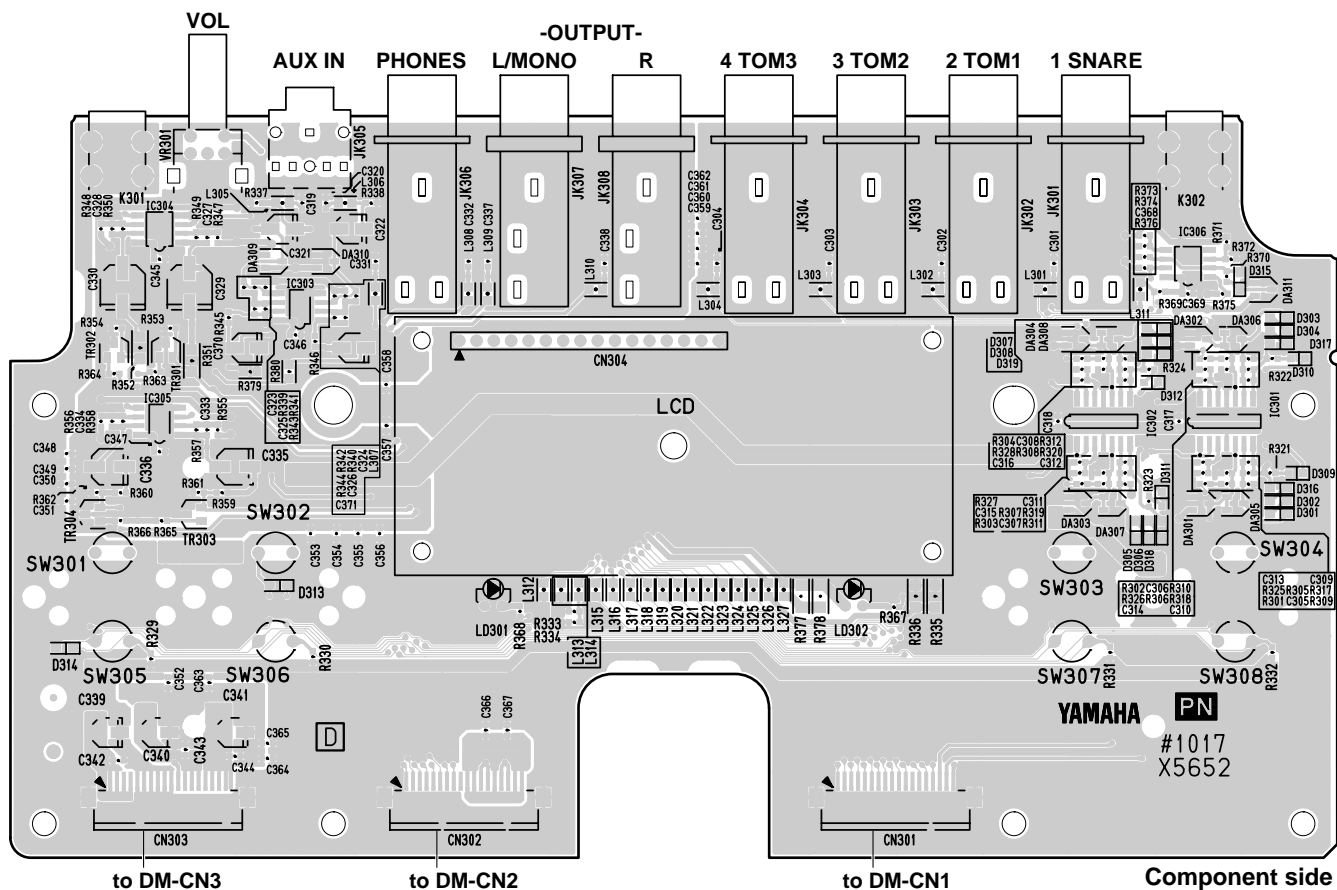
● RE Circuit Board  
(Same as for version C)




Pattern side



● PN Circuit Board (Same as for version C)



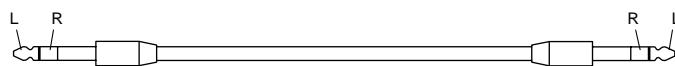
DM, RE: ENA-WD41150 

## ■ TEST PROGRAM

Test No.	Title	Judgment criteria, etc.
	MEASURING CONDITION	
A	TEST ENTRY	
B	CARRYING ON THE TEST AND THE TEST AT THE TIME OF FAIL	
C	TEST ITEM	
C-01.	ROM	PROGRAM ROM READ (Automatic test)
C-02.	SRAM	SRAM READ / WRITE (Automatic test)
C-03.	BATTERY	BUTTON BATTERY (Automatic test)
C-04.	MIDI OUT	OUTPUT AT KEY ON/OFF
C-05.	LCD	CHECK VISUALLY / DISPLAY EACH PATTERN ON LCD
C-06.	LED	CHECK VISUALLY / LED ON/OFF
C-07.	SW	PANEL SWITCH ON
C-08.	ROTARY ENCODER	LEFT, RIGHT
C-09.	TRIGGER IN 1	
C-10.	TRIGGER IN 2	
C-11.	TRIGGER IN 3	
C-12.	TRIGGER IN 4	
C-13.	TRIGGER IN 5	
C-14.	TRIGGER IN 6	
C-15.	TRIGGER IN 7	
C-16.	TRIGGER IN 8	
C-17.	TRIGGER IN 9	
C-18.	RIM SW IN 1	Check the switch for ON/OFF operation.
C-19.	RIM SW L IN 1	Check the switch for ON/OFF operation. (3 zone side)
C-20.	RIM SW IN 5	Check the switch for ON/OFF operation.
C-21.	RIM SW IN 6	Check the switch for ON/OFF operation.
C-22.	HI HAT CONTROL	Maximum, Minimum
C-23.	OUTPUT L 1 kHz	Measurement
C-24.	OUTPUT R 1 kHz	Measurement
C-25.	AUX IN	Measurement
C-26.	32 ch OUT	Auditory check
C-27.	FACTORY SET	

### Measuring condition

- 1) Use PA-3C (adapter).
- 2) Measuring instruments  
Low-frequency oscillator, level meter, analog waveform measuring instrument, and powered speaker.  
\* To measure audio output, use JIS C filter.
- 3) Jigs  
MIDI cable, USB cable, stereo (TRS) phone cable, and MIDI IN compatible module.  
Pad with 3 zone RIM switch (TP-65S etc.), HI-HAT controller. (HH65)



Stereo phone cable

**A. TEST ENTRY**

Perform the following operation when turning on power for the main unit.

Turn on power for the main unit while holding down the following buttons at the same time.

[KIT]+[SAVE/ENTER]

```
DIAG att cr xt
677f 3a50 04
```

In case of any change, set each of the parameters below.

\*Note that the change from ver. 1.00 to 1.02 is followed by a change of CR value.  
Also change ver. 1.00 to "3a50" and check it.

For parameter setting, select the parameter you want to change using [ ] and [ ], and set it with ROTARY ENCODER. Each parameter is detailed below.

- All parameters are ranged from 00 to ff.
- The values referred to as the upper and lower limits are also included in the OK range.

67 — Lower limit in the OK range in INPUT 1-9  
7f — Upper limit in the OK range in INPUT 1-9  
3a — Lower limit in the OK range after elapse of time in the time constant test for INPUT 1-9  
50 — Upper limit in the OK range after elapse of time in the time constant test for INPUT 1-9  
04 — Upper limit for the cross talk value in INPUT 1-9

\*After changing all parameters, press [SAVE/ENTER] and the "Test No. Selection Screen" appears.

**B. CARRYING ON THE TEST AND THE TEST AT THE TIME OF FAIL**

In case of TEST ENTRY, the following screen first appears.

```
DIAG att cr xt
677f 3a50 04
```

In case of any change, set each parameter below.  
For parameter setting, select the parameter you want to change using [ ] and [ ], and set it with ROTARY ENCODER.

Pressing the [SAVE/ENTER] key displays the following screen.

```
1 ROM
```

- This state is called the "Test No. Selection Screen".
- Using the [ ] and [ ] keys, select the Test No. and press the [SAVE/ENTER] key. The test can be automatically performed in order of Test No. starting with the selected Test No.
- In case of failure, the test stops with FAIL indicated.

Carrying on the test which is judged to be FAIL.

- Press the [SHIFT] key in case each test is judged to be FAIL. The Test No. Selection Screen will appear.

**C-01. ROM**

[Initial indication]

```
1 ROM
```

[Test content]

Read the data for ROM (IC2) and verify it.

[Test method]

Perform the test.

[Check item]

Check the result on the LCD.

[Indication of judgment result]

In case of OK

Go on to the next test.

In case of NG

```
1 ROM
FAIL ****
```

[Content of FAIL judgment]

Not available

[Completing the test]

OK: The test will proceed to the next one automatically.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-2. SRAM**

[Initial indication]

```
2 SRAM
```

[Test content]

WRITE/READ the data "A5" to SRAM (IC3) and perform Verify Check.

[Test method]

Perform the test.

[Check item]

Check the result on the LCD.

[Indication of judgment result]

In case of OK

Go on to the next test.

In case of NG

```
2 SRAM
FAIL
```

[Content of FAIL judgment]

Not available

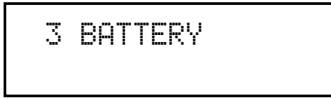
[Completing the test]

OK: The test will proceed to the next one automatically.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-03. BATTERY**

[Initial indication]

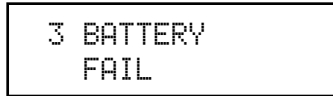


[Test content]  
Check that the battery is new.

[Test method]  
Perform the test.

[Check item]  
Check the result on the LCD.

[Indication of judgment result]  
In case of OK  
Go on to the next test.  
In case of NG

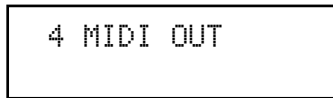


[Content of FAIL judgment]  
Not available

[Completing the test]  
OK: The test will proceed to the next one automatically.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-4. MIDI OUT**

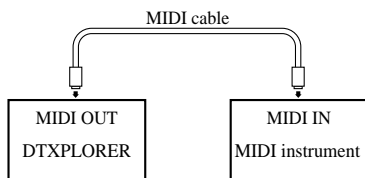
[Initial indication]



[Test content]  
Output key on (90 3C 7F) from MIDI OUT. Output key off (90 3C 00) after 500 msec.

[Test method]  
After connecting MIDI OUT and I/O box with the MIDI cable, perform the test.

[Check item]  
Check that MIDI code is transmitted.



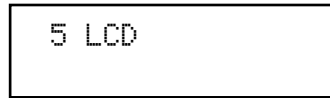
[Indication of judgment result]  
Not available

[Content of FAIL judgment]  
Not available

[Completing the test]  
OK: In case of OK, press [SAVE/ENTER].  
The test proceeds to the next one.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-05. LCD**

[Initial indication]



[Test content]  
Visually check the dots on the LCD.

[Test method]  
Check that all dots flash on and off alternately.

[Check item]  
Check the result on the LCD.

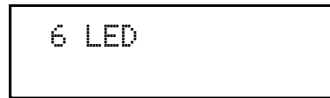
[Indication of judgment result]  
Not available

[Content of FAIL judgment]  
Not available

[Completing the test]  
OK: In case of OK, press [SAVE/ENTER].  
The test proceeds to the next one.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-6. LED**

[Initial indication]



[Test content]  
Make sure that the LED lights up correctly.

[Test method]  
Check that the LEDs light up in the following order.  
BEAT (RED) CLICK (GREEN) Both light up.

[Check item]  
Check that the LEDs light up in the above order.  
Visually check that the LEDs are not too dark.

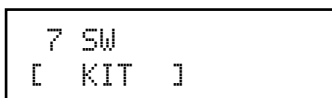
[Indication of judgment result]  
Not available

[Content of FAIL judgment]  
Not available

[Completing the test]  
OK: In case of OK, press [SAVE/ENTER].  
The test proceeds to the next one.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-07. PANEL SWITCH**

[Initial indication]

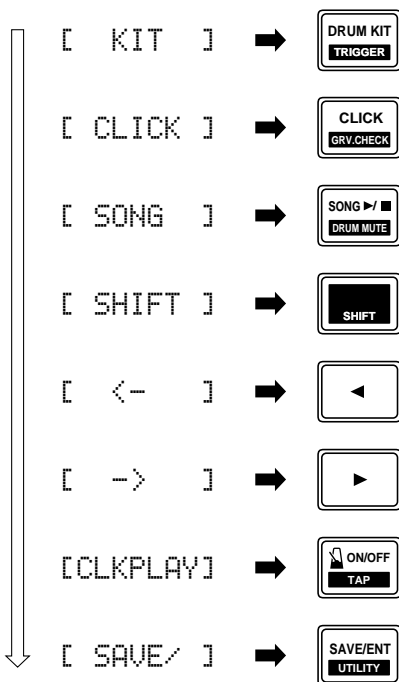


[Test content]

Make sure that the panel switches turn on and off correctly.

[Test method]

Turn on the panel switches from [KIT] to [SAVE/ENTER] according to the LCD indication as shown below.



[Check item]

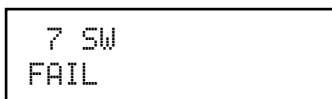
Check the result on the LCD.

[Indication of judgment result]

In case of OK

Go on to the next test.

In case of NG



[Content of FAIL judgment]

Not available

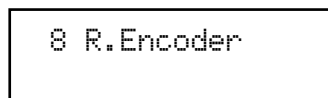
[Completing the test]

OK: The test will proceed to the next one automatically.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-8. ROTARY ENCODER**

[Initial indication]

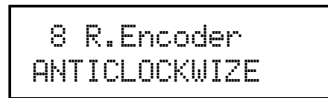
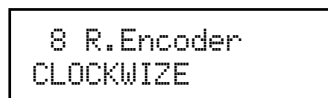


[Test content]

Make sure that ROTARY ENCODER operates correctly.

[Test method]

Rotate ROTARY ENCODER clockwise or anticlockwise according to the LCD indication.



[Check item]

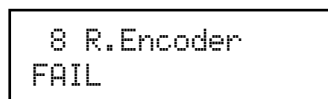
Check the result on the LCD.

[Indication of judgment result]

In case of OK

Go on to the next test.

In case of NG



[Content of FAIL judgment]

Not available

[Completing the test]

OK: The test will proceed to the next one automatically.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-9. TRIGGER IN 1**

**C-10. TRIGGER IN 2**

**C-11. TRIGGER IN 3**

**C-12. TRIGGER IN 4**

**C-13. TRIGGER IN 5**

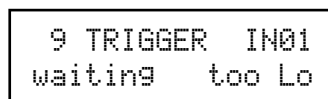
**C-14. TRIGGER IN 6**

**C-15. TRIGGER IN 7**

**C-16. TRIGGER IN 8**

**C-17. TRIGGER IN 9**

[Initial indication]



[Test content]

Add looped signals from PHONES when inputting 1.SNARE — 8.KICK/9 and check that the inputted signals are entered into CPU with correct values. Also check that no signals are leaked to other inputs.

\*Output wave from PHONES is a tone burst sine wave with a frequency of 4 kHz and +4 dBm (load of 10 k ohm).

[Test method]

Maximize VOLUME.  
Put in the stereo cable looped from PHONES in order starting with 1.SNARE.  
In case of OK, proceed to the next INPUT and the following apparatus.

```

9 TRIGGER IN02
waiting too Lo
    
```

So, put in 2.TOM1.  
Repeat the sequence until it gets to 8.KICK/9.

[Check item]

Check the result on the LCD.

[Indication of judgment result]

In case of OK  
Go on to the next test.  
In case of NG

```

9 TRIGGER IN02
FAIL XXXXX
    
```

XXXXX refers to "too High", "XtalkIN2", "BAD CR", etc.

[Content of FAIL judgment]

The test no longer proceeds to the next one.

[Completing the test]

OK: The test will proceed to the next one automatically.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

- C-18. RIM SW IN 1**
- C-19. RIM SW L IN 1**
- C-20. RIM SW IN 5**
- C-21. RIM SW IN 6**

[Initial indication]

```

18 RIM SW IN01
waiting
    
```

[Test content]

For input at three locations, i.e. 1.SNARE, 5.RIDE, and 6.CRASH, connect the RIM switch-fitted pad and check for correct operation. For IN1, also check 3 zone rim switch.

[Test method]

Connect the 3 zone RIM switch-fitted pad with each jack in order of INPUT 1, 5, and 6 and turn on the RIM switch.

```

18 RIM SW IN01
waiting
    
```

In case of OK

```

19 RIM SW L IN01
waiting
    
```

The above appears, so press the switch for the 3 zone side.  
In case of OK, proceed to the next one and enter into 5.RIDE.  
Likewise, check up to 6.CRASH.

[Check item]

Check the result on the LCD.

[Indication of judgment result]

In case of OK  
Go on to the next test.  
In case of NG

```

29 RIM SW IN01
FAIL
    
```

[Content of FAIL judgment]

The test no longer proceeds to the next one.

[Completing the test]

OK: The test will proceed to the next one automatically.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-22. HI HAT CONTROL**

[Initial indication]

```

22 H.H. CONT.
    
```

[Test content]

Check that the HI-HAT controller allows the control to operate correctly.

[Test method]

Insert the HI-HAT controller plug into the jack of HI-HAT control. Operate the sensor to the upper and the lower limit. (Order does not matter.)

[Check item]

Check the result on the LCD.

[Indication of judgment result]

In case of OK  
Go on to the next test.  
In case of NG  
Not available

[Content of FAIL judgment]

Controller operation will not allow the next test to follow.

[Completing the test]

OK: The test will proceed to the next one automatically.

**C-23. OUTPUT L 1 kHz**

[Initial indication]

```

23 OUTPUT L 1kHz
    
```

[Test content]

Check that correct signals are outputted from OUTPUT (L/MONO).

## [Test method]

Insert the phone plugs into OUTPUT (for L/MONO, R) and measure the frequency, output waveform, and output level of each output.

Maximize VOLUME.

For AUX IN, make sure that the plug is not inserted or that the input voltage is -70 dBm or less.

## [Check item]

OUTPUT (L/MONO): 1 kHz +/- 3 Hz, SIN wave, -5.5 +/-2 dBm (load of 10 k ohm), distortion factor of 0.5 % or less\*<sup>1</sup>

OUTPUT (R): -65 dBm or less\*<sup>2</sup> (load of 10 k ohm)

In case the plug is pulled out of OUTPUT (R)

OUTPUT (L/MONO): 1 kHz +/- 3 Hz, SIN wave, -11.0 +/-2 dBm (load of 10 k ohm), distortion factor of 0.5 % or less\*<sup>1</sup>

\*1,\*2: For inspection of the circuit board, the distortion factor must be 1.0 % or less and the sound -60 dBm or less.

## [Indication of judgment result]

Not available

## [Content of FAIL judgment]

Not available

## [Completing the test]

OK: In case of OK, press [SAVE/ENTER].

The test proceeds to the next one.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-24. OUTPUT R 1 kHz**

## [Initial indication]



## [Test content]

Check that correct signals are outputted from OUTPUT (R).

## [Test method]

Insert the standard plugs into OUTPUT (for L/MONO, R) and measure the frequency, output waveform, and output level of each output.

Maximize VOLUME.

For AUX IN, make sure that the plug is not inserted or that the input voltage is -70 dBm or less.

## [Check item]

OUTPUT (R): 1 kHz +/- 3 Hz, SIN wave, -5.5 +/-2 dBm (load of 10 k ohm),

distortion factor of 0.5 % or less\*<sup>1</sup>

OUTPUT (L/MONO): -65 dBm or less\*<sup>2</sup> (load of 10 k ohm)

\*1,\*2: For inspection of the circuit board, the distortion factor must be 1.0 % or less and the sound -60 dBm or less.

## [Indication of judgment result]

Not available

## [Content of FAIL judgment]

Not available

## [Completing the test]

OK: In case of OK, press [SAVE/ENTER].

The test proceeds to the next one.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-25. AUX IN**

## [Initial indication]



## [Test content]

Check that the signals coming in form AUX IN are being outputted as correct signals.

## [Test method]

Input sine waves into AUX IN (L, R) and with the standard stereo phone plugs inserted into PHONES (L, R), measure the frequency and output wave level of PHONES.

## [Check item]

Input a sine wave of -20 dBm and 1 kHz into AUX IN (L) (with AUX IN (R) grounded).

Maximize VOLUME.

PHONES (L): -7.0 +/-2 dBm (Load of 33 ohm), distortion factor of 0.5 % or less\*<sup>1</sup>

PHONES (R): -65 dBm or less\*<sup>2</sup> (Load of 33 ohm)

Input a sine wave of -20 dBm and 1 kHz into AUX IN (R) (with AUX IN (L) grounded).

Maximize VOLUME.

PHONES (L): -65 dBm or less\*<sup>2</sup> (Load of 33 ohm)

PHONES (R): -7.0 +/-2 dBm (Load of 33 ohm), distortion factor of 0.5 % or less\*<sup>1</sup>

\*1,\*2: For inspection of the circuit board, the distortion factor must be 1.0 % or less and the sound -60 dBm or less.

## [Indication of judgment result]

Not available

## [Content of FAIL judgment]

Not available

## [Completing the test]

OK: In case of OK, press [SAVE/ENTER].

The test proceeds to the next one.

NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-26. 32 ch OUT**

## [Initial indication]

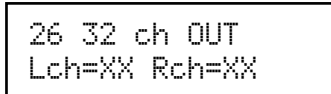


[Test content]

Check that 32 sounds are correctly produced with 1 to 16 ch producing sounds from OUTPUT (L/MONO) and 17 to 32 ch producing sounds from OUTPUT (R).

[Test method]

Pressing SAVE/ENTER causes the LCD to indicate the following, with a sound (approx. 0.3 sec.) and no sound (approx. 0.1 sec.) being repeated 16 times.  
Maximize VOLUME.



XX: No. of channel currently producing sounds.

[Check item]

Auditorily check that 32 sounds are produced correctly.

[Indication of judgment result]

Not available

[Content of FAIL judgment]

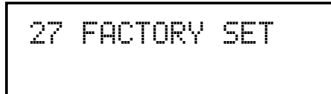
Not available

[Completing the test]

OK: In case of OK, press [SAVE/ENTER].  
The test proceeds to the next one.  
NG: For handling the FAIL judgment, see "B. CARRYING ON THE TEST".

**C-27. FACTORY SET**

[Initial indication]



[Test content]

Set to the factory settings.

[Test method]

Pressing [SAVE/ENTER] allows the factory setting to be set.

[Check item]

Not available

[Indication of judgment result]

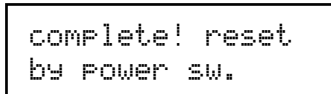
Not available

[Content of FAIL judgment]

Not available

[Completing the test]

At the end of test mode, the following indication appears.



Turn on power again and perform the test for sound production in the following order in the normal mode of the main unit.

**Others. Version Check**

You can check the ROM version if you turn on power while holding down the [SHIFT] key.

**Inspecting the Main Unit for Sound Production**

1. When play mode starts after test mode is completed, maximize VOLUME and check that the noise level meets the requirements below.

OUTPUT (L/MONO): -75 dBm or less (Load of 10 k ohm)

OUTPUT (R): -75 dBm or less (Load of 10 k ohm)

PHONES (L): -75 dBm or less (Load of 33 ohm)

PHONES (R): -75 dBm or less (Load of 33 ohm)

2. With VOLUME maximized, turn on and off power several times and check that no clicks are produced.
3. Connect the speakers with OUTPUT L and R and turn on power. Press [SONG] two times and check that music is produced. Check that the tone is not distorted.
4. Turn VOLUME in order of "MIN" and "MAX" and check that the volume changes from zero to maximum.
5. Press the [SONG] button and check that the production of music stops.
6. For factory setting, hold down [ ] and [ ] at the same time and turn on power.  
\* Perform the factory setting as required.



## ■ ERROR MESSAGES

An Error Message will appear when incorrect settings or operation are detected, or abnormal operation occurs.

Check the Error Message below and make the appropriate corrections.

ERROR  
Data Initialized

This message appears just after the power is switched on and the device can not correctly read the data. The cause of the problem may be that the backup RAM data has been damaged or the backup battery power is low.

WARNING  
Battery Low

The internal memory backup battery power is too low. User data may be deleted.

## ■ MIDI IMPLEMENTATION CHART

YAMAHA [ Drum Trigger Module ]  
Model DTXPLOER MIDI Implementation Chart

Date:04-Jun-2004  
Version : 1.0

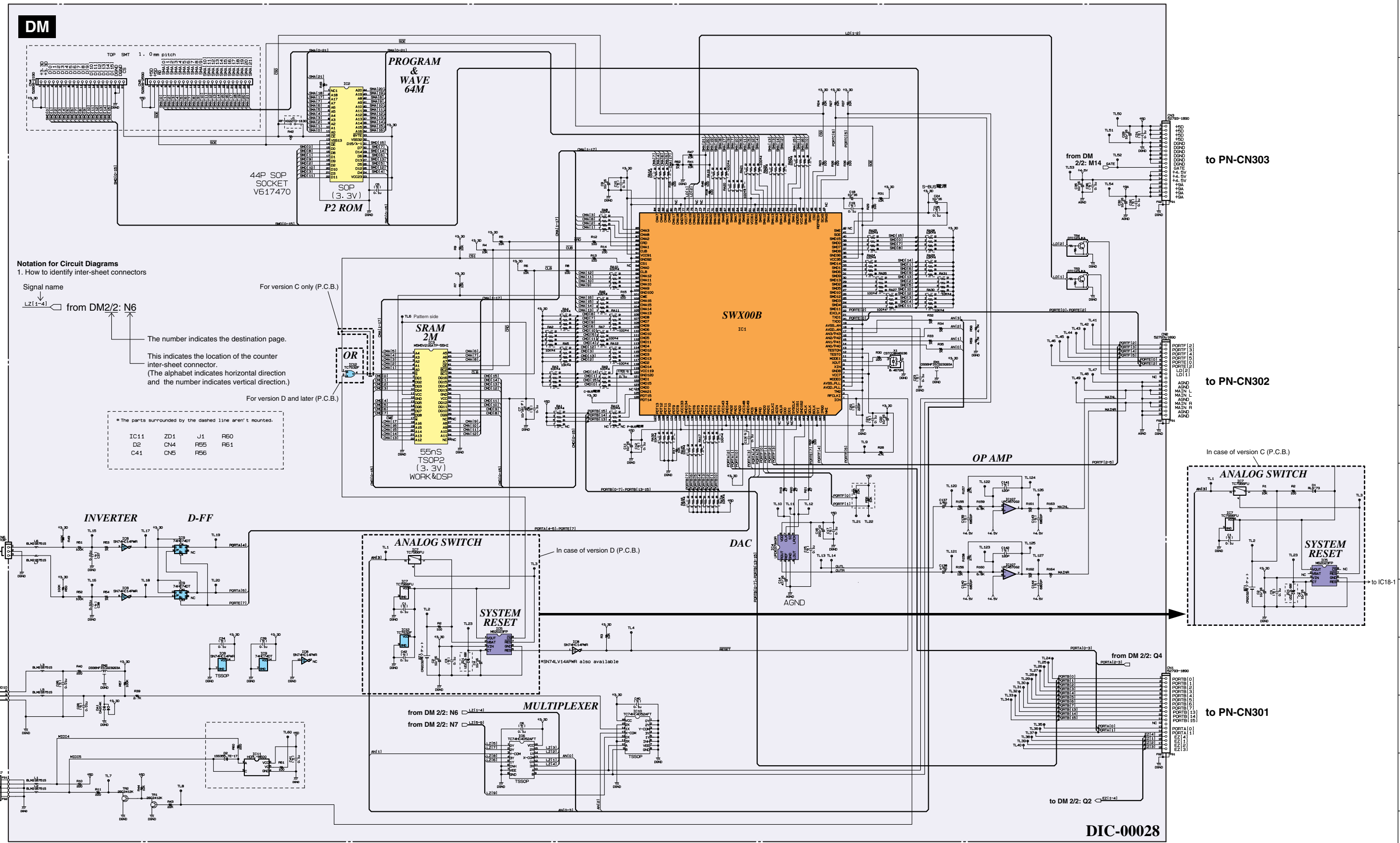
Function ...	Transmitted	Remarks
Basic Default Channel Changed	1 - 16 1 - 16	memorized
Mode Default Messages Altered	x x *****	
Note Number : True voice	0 - 127 0 - 127	
Velocity Note ON Note OFF	o 9nH,v=1-127 x 9nH,v=0	
After Key's Touch Ch's	x x	
Pitch Bender	x	
Control Change	0,4,7,10,32 o 1,6,11,64 x 71,72,73 x 74,84,91 x 100,101 x	
Prog Change : True #	o 0 - 127 *****	
System Exclusive	o	
System : Song Pos. : Song Sel. Common : Tune	x x x	
System :Clock Real Time :Commands	o o	
Aux :All Sound Off :Reset All Cntrls :Local ON/OFF :All Notes OFF Mes- :Active Sense sages:Reset	x x x x o x	

Mode 1 : OMNI ON, POLY  
Mode 3 : OMNI OFF, POLY

Mode 2 : OMNI ON, MONO  
Mode 4 : OMNI OFF, MONO

o : Yes  
x : No

# DM 1/2 CIRCUIT DIAGRAM (DTXPLOER)

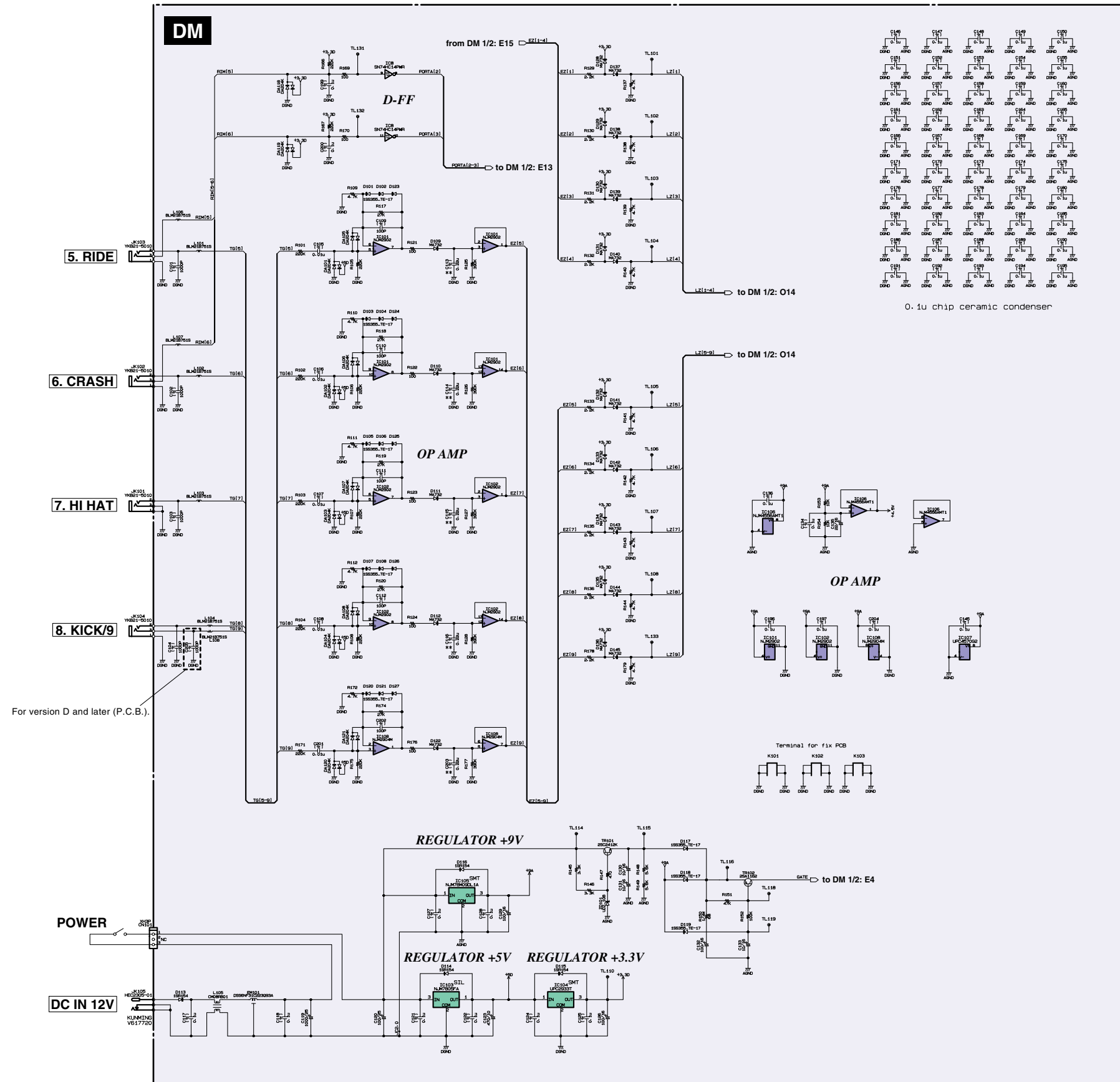


Parts inside of (\*), are not installed.

Note: See parts list for details of circuit board component parts.

- (セ): Ceramic Capacitor
- (タ): Tantalum Capacitor

DM 2/2 CIRCUIT DIAGRAM (DTXPLOER)



•NJM7805FA (XJ607A00)  
REGULATOR +5V  
DM: IC103

1: OUTPUT  
2: COMMON  
3: INPUT

---

•UPC2933AT-E1(X0638A00)  
REGULATOR +3.3V  
DM: IC104

1: INPUT  
2: GND  
3: OUTPUT  
4: GND

---

•NJM78M09DL1A (XZ940A00)  
REGULATOR +9V  
DM: IC105

1: INPUT  
2: GND  
3: OUTPUT

**Notation for Circuit Diagrams**  
1. How to identify inter-sheet connectors

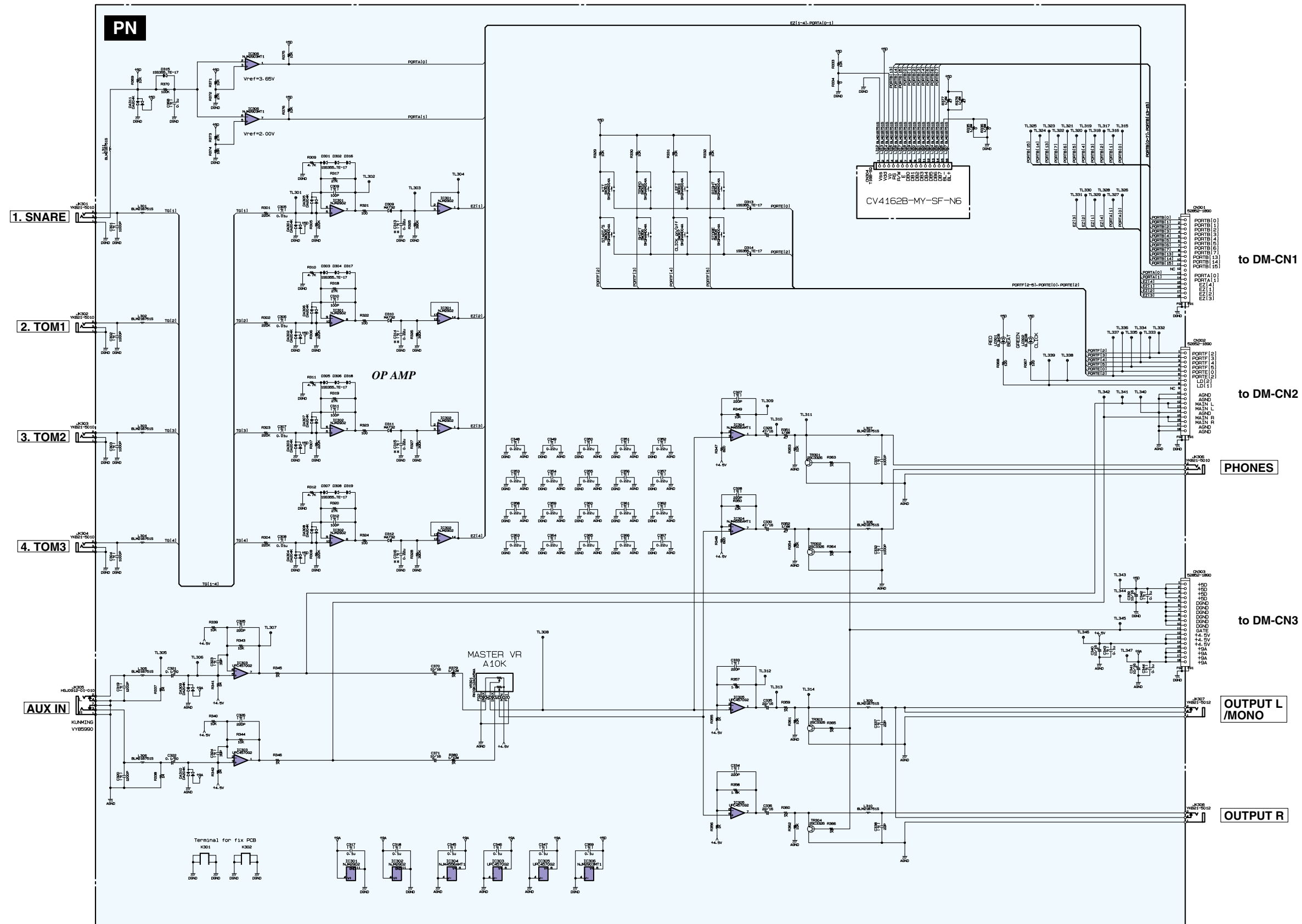
Signal name  
LZ11-41 to DM1/2: O14

The number indicates the destination page.

This indicates the location of the counter inter-sheet connector.  
(The alphabet indicates horizontal direction and the number indicates vertical direction.)

Note: See parts list for details of circuit board component parts.

PN CIRCUIT DIAGURAM (DTXPLOER)



(七): Ceramic Capacitor

Note: See parts list for details of circuit board component parts.

# DRUM TRIGGER MODULE DTXPLORER

## PARTS LIST

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### Notes: DESTINATION ABBREVIATIONS

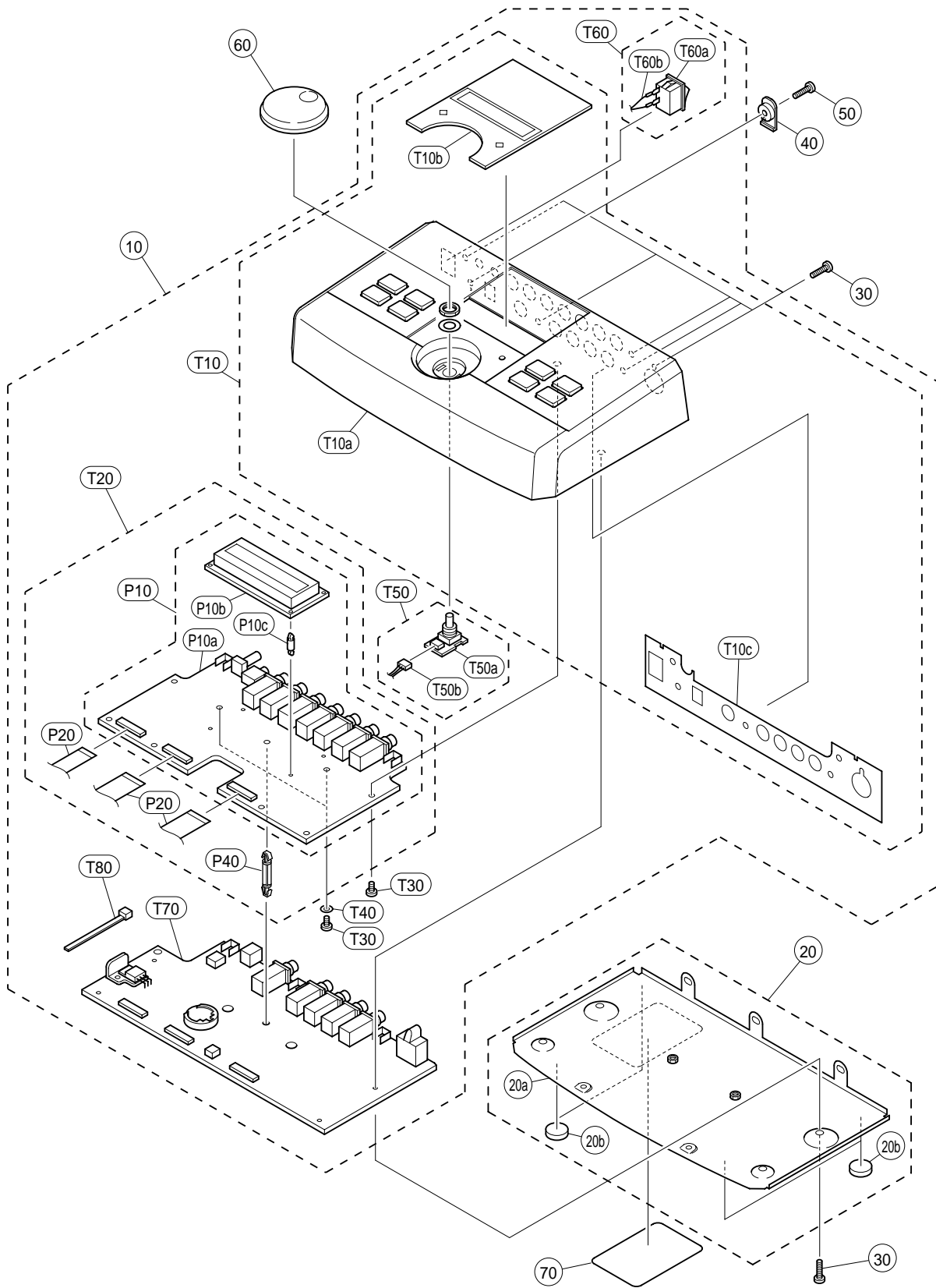
A: Australian model	O: Chinese model
B: British model	U: U.S.A. model
C: Canadian model	V: General export model (110V)
E: European model	W: General export model (220V)
H: North European model	X: General export model
I: Indonesian model	Y: Export model
J: Japanese model	

- The numbers in "QTY" show quantities for each unit.
- The parts with "--" in "Parts No." are not available as spare parts.
- The mark "{" in the remarks column indicates that these parts are interchangeable.

### ■ WARNING

Components having special characteristics are marked  and must be replaced with parts having specification equal to those originally installed.

# OVERALL ASSEMBLY



REF NO.	PART NO.	DESCRIPTION		部 品 名	REMARKS	QTY	RANK
		OVERALL ASSEMBLY		総 組 立	DTXPLOER		
	--	Overall Assembly		総 組 立 D T X P L	(WD55950)		
* 10	<b>WD559400</b>	Top Unit		ト ッ プ ユ ニ ッ ト			
* 20	<b>WD559300</b>	Bottom Case Assembly		B ケ ー ス A s s ' y			
* 20a	<b>WD558600</b>	Bottom Case		ボ ト ム ケ ー ス 印 刷 品			
* 20b	<b>WD554200</b>	Rubber foot		ラ ッ タ ー フ ッ ト		4	
* 30	<b>VQ074600</b>	Bind Head Tapping Screw-B	3.0X12 MFZN2BL	+ バ イ ン ド B タ イ ト		11	01
* 40	<b>WD553500</b>	Cord Column		D C コ ー ド コ ラ ム			
* 50	<b>VQ074600</b>	Bind Head Tapping Screw-B	3.0X12 MFZN2BL	+ バ イ ン ド B タ イ ト			01
* 60	<b>WD553700</b>	Rotary Encoder Knob		エ ン コ ー ダ ー ノ ブ			
* 70	--	Label		バ ー コ ー ド ラ べ ル	(WD56040)		
* T10	<b>WD559400</b>	Top Unit		ト ッ プ ユ ニ ッ ト			
* T10a	<b>WD558800</b>	Top Case Assembly		ト ッ プ ケ ー ス A s s ' y			
* T10a	<b>WD558700</b>	Top Case S Assembly		T ケ ー ス S A s s ' y	DRUM KIT, CLICK, SONG ▶/■, SHIFT, ◀, ▶, ON/OFF, SAVE/ENT		
* T10b	<b>WD558900</b>	LCD Panel Assembly		L C D パ ー ネ ル A s s ' y			
* T10c	--	Shield Sheet		シ ー ル ド シ ー ト	(WD55430)		
* T20	--	Circuit Board Assembly	PN	P N シ ー ト A s s ' y	(WD55900)		
* T30	<b>EP600190</b>	Bind Head Tapping Screw-B	3.0X8 MFZN2BL	+ バ イ ン ド B タ イ ト		8	01
* T40	<b>03765580</b>	Flat Washer	3.0X8X0.5 MFZN2BL	平 座 金 み が き 丸		2	01
* T50	<b>WD559100</b>	Circuit Board Assembly	RE	R E シ ー ト A s s ' y			
* T50a	<b>WD411800</b>	Circuit Board	RE	R E シ ー ト	(WD41150)(X5652C0/D0)		
* T50b	<b>WD584300</b>	Connector Assembly	RE	R E 束 線 A s s ' y			
* T60	<b>WD559200</b>	Power Switch Assembly	L	電 源 S W A s s ' y	POWER STANDBY		
* T60a	<b>V7054700</b>	Power Switch	SDDJE1-A-2	パ ワ ー S W			02
* T60b	<b>WD584200</b>	Connector Assembly	PSW	P S W 束 線 A s s ' y			
* T70	<b>WD411600</b>	Circuit Board	DM	D M シ ー ト	(WD41150)(X5652C0/D0)		
* T80	<b>WD749900</b>	Cord Holder		イ ン シ ュ ロ ッ ク タイ			
* P10	--	Circuit Board Assembly	PN	P N シ ー ト A s s ' y	(WD55900)		
* P10a	<b>WD584500</b>	Sub-assembly	PN	P N サ ブ A s s ' y			
* P10b	--	Circuit Board	PN	P N シ ー ト	(WD41170)		
* P10c	--	LCD Assembly		L C D A s s ' y	(WD58440)		
* P10c	--	Spacer Support	MCD2-6	ス ペ ー サ ー サ ポ ー ト	(WD55390)	4	
* P20	<b>MFA18060</b>	Connector Assembly	18P 60mm P=1.0	カ ー ド 電 線		3	
* P40	<b>WD554000</b>	Spacer Support	KCA-15	ス ペ ー サ ー サ ポ ー ト			
* P50	--	Wire Black	AWG28 1007 TR64	ビ ニ ー ル 線 . ク ロ	(VA14770)		
* △ △ △		ACCESSORIES		付 属 品			
	<b>V8028600</b>	AC Adapter	PA-3C J	A C ア ダ プ タ	J		06
	<b>V8028700</b>	AC Adapter	PA-3C U	A C ア ダ プ タ	U,C		
	<b>V8028800</b>	AC Adapter	PA-3C E	A C ア ダ プ タ	H		08

\*: New parts

RANK: Japan only



# ELECTRICAL PARTS

REF NO.	PART NO.	DESCRIPTION	部 品 名	REMARKS	QTY	RANK
		ELECTRICAL PARTS	電 気 部 品	DTXPLOER		
*	WD411600	Circuit Board	D M シ ー ト	(WD41150)(X5652C0/D0)		
*	WD584500	Circuit Board	P N サ ブ A s s ' y	(WD41150)(X5652C0/D0)		
*	WD411800	Circuit Board	R E シ ー ト	(WD41150)(X5652C0/D0)		
*	WD411600	Circuit Board	D M シ ー ト	(WD41150)(X5652C0/D0)		
*	WD584500	Circuit Board	P N サ ブ A s s ' y	(WD41150)(X5652C0/D0)		
*	WD411800	Circuit Board	R E シ ー ト	(WD41150)(X5652C0/D0)		
	--	Heat Sink	ヒ ー ト シ ン ク	(WD55340)		
*	EP600190	Bind Head Tapping Screw-B	3.0X8 MFZN2BL	+ バ イ ン ド B タ イ ト		01
*	WD554100	Terminal Plate		ターミナル金具		2
*	WD760300	LED Holder	LEDS-9.5	L E D ホ ル ダ ー		2
BT001	VN103600	Battery Holder	CR2032	バ ッ テ リ ー ホ ル ダ ー		03
BT002	VE338400	Lithium Battery	CR2032HC2HY	リ チ ュ ウ ム 電 池		03
C0001	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0002	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0003	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0004	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0005	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0006	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
*	C0007	VR728200	Tantalum Cap.-TE (chip)	10 16V M	タンタル チ ッ プ T E	
C0008	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0009	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0010	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0011	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0012	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0013	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0014	UF037470	Electrolytic Cap. (chip)	47 16V	チ ッ プ ケ ミ コ ン		01
C0015	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0016	UF128220	Electrolytic Cap. (chip)	220 10V UUR1A2	チ ッ プ ケ ミ コ ン		01
C0017	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0018	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0019	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0020	US062220	Ceramic Capacitor-SL(chip)	220P 50V J	チ ッ プ セ ラ ( S L )		01
C0021	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0022	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0023	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0024	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0025	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0026	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )		01
C0028	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )		01
C0029	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0030	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0031	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
-0034	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0035	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0036	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0037	UX064100	Ceramic Capacitor (chip)	0.0100 50V K	チ ッ プ セ ラ		01
C0038	UX064100	Ceramic Capacitor (chip)	0.0100 50V K	チ ッ プ セ ラ		01
C0039	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0040	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0042	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )	For X5652D0 and later	01
C0101	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )		01
-0104	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )		01
C0105	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )		01
-0108	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )		01
C0109	US062100	Ceramic Capacitor-SL(chip)	100P 50V J	チ ッ プ セ ラ ( S L )		01
-0112	US062100	Ceramic Capacitor-SL(chip)	100P 50V J	チ ッ プ セ ラ ( S L )		01
C0113	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )		01
-0116	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )		01
C0117	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0118	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0119	UR849100	Electrolytic Cap.	1000 25.0V	ケ ミ コ ン		01
C0120	UF148100	Electrolytic Cap. (chip)	100 25V UUR1E1	チ ッ プ ケ ミ コ ン		01
C0121	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0122	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0123	UF128470	Electrolytic Cap. (chip)	470 10V UUR1A4	チ ッ プ ケ ミ コ ン		02
C0124	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0125	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0126	UF038100	Electrolytic Cap. (chip)	100 16V	チ ッ プ ケ ミ コ ン		01
C0127	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0128	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )		01
C0129	UF038100	Electrolytic Cap. (chip)	100 16V	チ ッ プ ケ ミ コ ン		01
C0130	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01
C0131	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン		01

\*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION		部 品 名	REMARKS	QTY	RANK
C0132	UF038100	Electrolytic Cap. (chip)	100 16V	チ ッ プ ケ ミ コ ン			01
C0133	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン			01
C0134	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0135	UF037220	Electrolytic Cap. (chip)	22 16V	チ ッ プ ケ ミ コ ン			01
C0136	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0137	UF066100	Electrolytic Cap. (chip)	1 50V	チ ッ プ ケ ミ コ ン			01
C0138	UF066100	Electrolytic Cap. (chip)	1 50V	チ ッ プ ケ ミ コ ン			01
C0139	US063680	Ceramic Capacitor-B (chip)	6800P 50V K	チ ッ プ セ ラ ( B )			01
C0140	US063680	Ceramic Capacitor-B (chip)	6800P 50V K	チ ッ プ セ ラ ( B )			01
C0141	US062120	Ceramic Capacitor-SL(chip)	120P 50V J	チ ッ プ セ ラ ( S L )			01
C0142	US062120	Ceramic Capacitor-SL(chip)	120P 50V J	チ ッ プ セ ラ ( S L )			01
C0143	US063680	Ceramic Capacitor-B (chip)	6800P 50V K	チ ッ プ セ ラ ( B )			01
C0144	US063680	Ceramic Capacitor-B (chip)	6800P 50V K	チ ッ プ セ ラ ( B )			01
C0145	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
-0200	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0201	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )			01
C0202	US062100	Ceramic Capacitor-SL(chip)	100P 50V J	チ ッ プ セ ラ ( S L )			01
C0203	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )			01
C0204	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0205	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )	For X5652D0 and later		01
C0301	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )			01
-0304	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )			01
C0305	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )			01
-0308	US064100	Ceramic Capacitor-B (chip)	0.0100 50V K	チ ッ プ セ ラ ( B )			01
C0309	US062100	Ceramic Capacitor-SL(chip)	100P 50V J	チ ッ プ セ ラ ( S L )			01
-0312	US062100	Ceramic Capacitor-SL(chip)	100P 50V J	チ ッ プ セ ラ ( S L )			01
C0313	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )			01
-0316	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )			01
C0317	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0318	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0319	US063120	Ceramic Capacitor-B (chip)	1200P 50V K	チ ッ プ セ ラ ( B )			01
C0320	US063120	Ceramic Capacitor-B (chip)	1200P 50V K	チ ッ プ セ ラ ( B )			01
C0321	UF065100	Electrolytic Cap. (chip)	0.1 50V	チ ッ プ ケ ミ コ ン			01
C0322	UF065100	Electrolytic Cap. (chip)	0.1 50V	チ ッ プ ケ ミ コ ン			01
C0323	US061390	Ceramic Capacitor-CH(chip)	39P 50V J	チ ッ プ セ ラ ( C H )			01
C0324	US061390	Ceramic Capacitor-CH(chip)	39P 50V J	チ ッ プ セ ラ ( C H )			01
C0325	US062220	Ceramic Capacitor-SL(chip)	220P 50V J	チ ッ プ セ ラ ( S L )			01
-0328	US062220	Ceramic Capacitor-SL(chip)	220P 50V J	チ ッ プ セ ラ ( S L )			01
C0329	UF037470	Electrolytic Cap. (chip)	47 16V	チ ッ プ ケ ミ コ ン			01
C0330	UF037470	Electrolytic Cap. (chip)	47 16V	チ ッ プ ケ ミ コ ン			01
C0331	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )			01
C0332	US063100	Ceramic Capacitor-B (chip)	1000P 50V K	チ ッ プ セ ラ ( B )			01
C0333	US062220	Ceramic Capacitor-SL(chip)	220P 50V J	チ ッ プ セ ラ ( S L )			01
C0334	US062220	Ceramic Capacitor-SL(chip)	220P 50V J	チ ッ プ セ ラ ( S L )			01
C0335	UF037220	Electrolytic Cap. (chip)	22 16V	チ ッ プ ケ ミ コ ン			01
C0336	UF037220	Electrolytic Cap. (chip)	22 16V	チ ッ プ ケ ミ コ ン			01
C0337	US061220	Ceramic Capacitor-CH(chip)	22P 50V J	チ ッ プ セ ラ ( C H )			01
C0338	US061220	Ceramic Capacitor-CH(chip)	22P 50V J	チ ッ プ セ ラ ( C H )			01
C0339	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン			01
-0341	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン			01
C0342	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
-0347	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0348	US135220	Ceramic Capacitor-F (chip)	0.2200 16V Z	チ ッ プ セ ラ ( F )			01
-0367	US135220	Ceramic Capacitor-F (chip)	0.2200 25V Z	チ ッ プ セ ラ ( F )			01
C0368	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0369	US145100	Ceramic Capacitor-F (chip)	0.1000 25V Z	チ ッ プ セ ラ ( F )			01
C0370	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン			01
C0371	UF037100	Electrolytic Cap. (chip)	10 16V	チ ッ プ ケ ミ コ ン			01
CN001	V3576000	Connector , FFC	52793 18P SE	F F C コ ネ ク タ ー			01
CN002	V3576000	Connector , FFC	52793 18P SE	F F C コ ネ ク タ ー			01
CN003	V3576000	Connector , FFC	52793 18P SE	F F C コ ネ ク タ ー			01
CN006	VB858200	Connector Base Post	PH- 3P SE	コ ネ ク タ ベ ー ス ポ ス ト			01
CN101	LB919030	Base Post Connector	XH 3P SE	ベ ー ス ツ キ ポ ス ト			01
CN301	WC547500	Connector , FFC	52852 18P SE	F F C コ ネ ク タ ー			01
CN302	WC547500	Connector , FFC	52852 18P SE	F F C コ ネ ク タ ー			01
CN303	WC547500	Connector , FFC	52852 18P SE	F F C コ ネ ク タ ー			01
CN401	VB858200	Connector Base Post	PH- 3P SE	コ ネ ク タ ベ ー ス ポ ス ト			01
DA001	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
DA101	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
-108	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
DA118	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
-121	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
DA301	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
-311	V3749000	Diode Array	DA204K 2A X2 T146	ダ イ オ ー ド ア レ イ			01
D0001	VV925900	Diode	RLS-73 TE-11	ダ イ オ ー ド	For X5652C0 only		01

\*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION	部 品 名	REMARKS	QTY	RANK
D0101	VT332900	Diode	1SS355 TE-17	ダイオード		01
-0108	VT332900	Diode	1SS355 TE-17	ダイオード		01
D0109	VQ721800	Diode	MA732	ダイオード		01
-0112	VQ721800	Diode	MA732	ダイオード		01
D0113	VT532500	Diode	1SR154-400	ダイオード		01
-0116	VT532500	Diode	1SR154-400	ダイオード		01
D0117	VT332900	Diode	1SS355 TE-17	ダイオード		01
-0121	VT332900	Diode	1SS355 TE-17	ダイオード		01
D0122	VQ721800	Diode	MA732	ダイオード		01
D0123	VT332900	Diode	1SS355 TE-17	ダイオード		01
-0127	VT332900	Diode	1SS355 TE-17	ダイオード		01
D0128	VQ721800	Diode	MA732	ダイオード		01
-0145	VQ721800	Diode	MA732	ダイオード		01
D0301	VT332900	Diode	1SS355 TE-17	ダイオード		01
-0308	VT332900	Diode	1SS355 TE-17	ダイオード		01
D0309	VQ721800	Diode	MA732	ダイオード		01
-0312	VQ721800	Diode	MA732	ダイオード		01
D0313	VT332900	Diode	1SS355 TE-17	ダイオード		01
-0319	VT332900	Diode	1SS355 TE-17	ダイオード		01
* EC401	WD536300	Rotary Encoder	EC12E2420802	ロータリーエンコーダ		01
EM001	VD542700	LC Filter	DSS6NF31C223Q93A	LCフィルタ-EMI		01
EM002	VD542700	LC Filter	DSS6NF31C223Q93A	LCフィルタ-EMI		01
EM101	VD542700	LC Filter	DSS6NF31C223Q93A	LCフィルタ-EMI		01
IC001	XU947C00	IC	HG73C205AFD	IC	SWX00B	09
* IC002	V6174700	Socket	IC179-44600-501	ICソケット44ピン付		
IC003	X3226A00	IC	M5M5V216ATP-55HI	IC	DRAM 2M	08
IC004	XR998A00	IC	UPD6379AGR	IC	DAC	04
IC005	X2163A00	IC	M62023FP	IC	SYSTEM RESET	03
IC006	XV869A00	IC	TC74HC4052AFT	IC	MULTIPLEXER	02
* IC007	XR867A00	IC	TC7S66FU	IC	ANALOG SWITCH	
* IC008	XZ288A00	IC	SN74HC14PWR	IC	INVERTER	
IC009	X2171A00	IC	74HC74DT	IC	D-FF	
IC010	XV869A00	IC	TC74HC4052AFT	IC	MULTIPLEXER	02
* IC011	X5800A00	IC	MR27V6402G	IC	MASK ROM 64M	
IC012	XM588A00	IC	TC7S32F	IC	OR For X5652D0 and later	
IC101	X4983A00	IC	NJM2902M(Te1)	IC	OP AMP	02
IC102	X4983A00	IC	NJM2902M(Te1)	IC	OP AMP	02
IC103	XJ607A00	IC	NJM7805FA	IC	REGULATOR +5V	02
IC104	X0638A00	IC	UPC2933AT-E1	IC	REGULATOR +3.3V	03
IC105	XZ940A00	IC	NJM78M09DL1A	IC	REGULATOR +9V	02
IC106	X5049A00	IC	NJM4556AM-TE1	IC	OP AMP	02
IC107	XF291A00	IC	UPC4570G2	IC	OP AMP	03
IC108	XV190A00	IC	NJM2904M	IC	OP AMP	01
IC301	X4983A00	IC	NJM2902M(Te1)	IC	OP AMP	02
IC302	X4983A00	IC	NJM2902M(Te1)	IC	OP AMP	02
IC303	XF291A00	IC	UPC4570G2	IC	OP AMP	03
IC304	X5049A00	IC	NJM4556AM-TE1	IC	OP AMP	02
IC305	XF291A00	IC	UPC4570G2	IC	OP AMP	03
* IC306	X5814A00	IC	NJM2903M(Te1)	IC	OP AMP	
JK001	VK018800	DIN Connector	5P YKF51-50	DINコネクタ1連	MIDI OUT	02
JK002	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	HH. CONT	01
JK101	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	7. HI HAT	01
JK102	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	6. CRASH	01
JK103	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	5. RIDE	01
JK104	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	8. KICK/9	01
JK105	VJ207400	DC-IN Jack	16V DC 3A HEC2305	DCジャック	DC IN 12V	01
JK301	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	1 SNARE	01
JK302	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	2 TOM1	01
JK303	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	3 TOM2	01
JK304	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	4 TOM3	01
JK305	VM552100	Phone Jack	ST HSJ0912-01-01	ホーンコネクタ	AUX IN	02
JK306	VE382300	Phone Jack	YKB21-5010	ホーンコネクタ	PHONES	01
JK307	VB312600	Phone Jack	YKB21-5012	ホーンコネクタ(黒)	OUTPUT L/MONO	02
JK308	VB312600	Phone Jack	YKB21-5012	ホーンコネクタ(黒)	OUTPUT R	02
LD301	VN433900	LED Red	GL3HD8	LED		01
LD302	VR043700	LED Light-green	GL3EG8	LED		01
L0001	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
-0007	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
L0101	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
-0104	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
L0105	VQ884000	Line Filter	CM08RB01	ラインフィルタ		03
L0106	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
-0108	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
L0301	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03
-0327	VS740100	Chip Inductance	BLM21B751S 2125	チップインダクタ		03

\*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION	部	品	名	REMARKS	QTY	RANK
RA001	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
-005	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
RA006	RE045100	Resistor Array	抵	抗	ア	レ	イ	01
-015	RE045100	Resistor Array	抵	抗	ア	レ	イ	01
RA016	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
RA017	RE045100	Resistor Array	抵	抗	ア	レ	イ	01
RA018	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
RA019	RE045100	Resistor Array	抵	抗	ア	レ	イ	01
-027	RE045100	Resistor Array	抵	抗	ア	レ	イ	01
RA028	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
-032	RE047100	Resistor Array	抵	抗	ア	レ	イ	01
R0001	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0002	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0003	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0007	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0008	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0009	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0010	RD355220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0011	RD355220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0012	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0016	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0017	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0018	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0019	RD354470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0021	RD354470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0022	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0023	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0024	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0026	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0027	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0028	RD357470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0029	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0030	RD355220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0031	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0032	RD356100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0035	RD356100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0036	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0037	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0039	RD356270	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0040	RD355220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0041	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0042	RD350000	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0043	RD357220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0044	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0046	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0047	RD357100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0048	RD350000	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0049	RD358100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0052	RD358100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0053	RD356100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0056	RD356100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0057	RD358100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0058	RD359470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0059	RD359470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0062	V9732900	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0101	RD358220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0108	RD358220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0109	RD356470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0112	RD356470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0117	RD357270	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0120	RD357270	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0121	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0124	RD355100	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0125	RD358390	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0128	RD358390	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0129	RD356220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0136	RD356220	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0137	RD356470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
-0144	RD356470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0145	RD356330	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0146	RD356330	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0147	RD355470	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0148	RD356560	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0149	RD356560	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01
R0150	RD154680	Carbon Resistor (chip)	チ	ッ	ブ	抵	抗	01

※: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION	部 品 名	REMARKS	QTY	RANK
R0151	RD357470	Carbon Resistor (chip)	47.0K 63M J	チ ッ プ 抵 抗		01
R0152	RD358100	Carbon Resistor (chip)	100.0K 63M J	チ ッ プ 抵 抗		01
R0153	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0154	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0155	RD357120	Carbon Resistor (chip)	12.0K 63M J	チ ッ プ 抵 抗		01
R0156	RD357120	Carbon Resistor (chip)	12.0K 63M J	チ ッ プ 抵 抗		01
R0157	RD357270	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0158	RD357270	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0159	RD356680	Carbon Resistor (chip)	6.8K 63M J	チ ッ プ 抵 抗		01
R0160	RD356680	Carbon Resistor (chip)	6.8K 63M J	チ ッ プ 抵 抗		01
R0161	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0162	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0163	RD350000	Carbon Resistor (chip)	0 63M J	チ ッ プ 抵 抗		01
R0164	RD350000	Carbon Resistor (chip)	0 63M J	チ ッ プ 抵 抗		01
R0166	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
R0167	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
R0169	RD355100	Carbon Resistor (chip)	100.0 63M J	チ ッ プ 抵 抗		01
R0170	RD355100	Carbon Resistor (chip)	100.0 63M J	チ ッ プ 抵 抗		01
R0171	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
R0172	RD356470	Carbon Resistor (chip)	4.7K 63M J	チ ッ プ 抵 抗		01
R0174	RD357270	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0175	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
R0176	RD355100	Carbon Resistor (chip)	100.0 63M J	チ ッ プ 抵 抗		01
R0177	RD358390	Carbon Resistor (chip)	390.0K 63M J	チ ッ プ 抵 抗		01
R0178	RD356220	Carbon Resistor (chip)	2.2K 63M J	チ ッ プ 抵 抗		01
R0179	RD356470	Carbon Resistor (chip)	4.7K 63M J	チ ッ プ 抵 抗		01
R0301	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
-0308	RD358220	Carbon Resistor (chip)	220.0K 63M J	チ ッ プ 抵 抗		01
R0309	RD356470	Carbon Resistor (chip)	4.7K 63M J	チ ッ プ 抵 抗		01
-0312	RD356470	Carbon Resistor (chip)	4.7K 63M J	チ ッ プ 抵 抗		01
R0317	RD357270	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
-0320	RD357270	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0321	RD355100	Carbon Resistor (chip)	100.0 63M J	チ ッ プ 抵 抗		01
-0324	RD355100	Carbon Resistor (chip)	100.0 63M J	チ ッ プ 抵 抗		01
R0325	RD358390	Carbon Resistor (chip)	390.0K 63M J	チ ッ プ 抵 抗		01
-0328	RD358390	Carbon Resistor (chip)	390.0K 63M J	チ ッ プ 抵 抗		01
R0329	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
-0333	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0334	RD350000	Carbon Resistor (chip)	0 63M J	チ ッ プ 抵 抗		01
R0335	RD150000	Carbon Resistor (chip)	0.0 1/4 J TP	チ ッ プ 抵 抗		01
R0336	RD150000	Carbon Resistor (chip)	0.0 1/4 J TP	チ ッ プ 抵 抗		01
R0336	RD155100	Carbon Resistor (chip)	100.0 1/4 J	チ ッ プ 抵 抗		01
R0337	RD359100	Carbon Resistor (chip)	1.0M 63M J	チ ッ プ 抵 抗		01
R0338	RD359100	Carbon Resistor (chip)	1.0M 63M J	チ ッ プ 抵 抗		01
R0339	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0340	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0341	RD359100	Carbon Resistor (chip)	1.0M 63M J	チ ッ プ 抵 抗		01
R0342	RD359100	Carbon Resistor (chip)	1.0M 63M J	チ ッ プ 抵 抗		01
R0343	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0344	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0345	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0346	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0347	RD355820	Carbon Resistor (chip)	820.0 63M J	チ ッ プ 抵 抗		01
R0348	RD355820	Carbon Resistor (chip)	820.0 63M J	チ ッ プ 抵 抗		01
R0349	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0350	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0351	RD154470	Carbon Resistor (chip)	47.0 1/4 J	チ ッ プ 抵 抗		01
R0352	RD154470	Carbon Resistor (chip)	47.0 1/4 J	チ ッ プ 抵 抗		01
R0353	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0354	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0355	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0356	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0357	RD356180	Carbon Resistor (chip)	1.8K 63M J	チ ッ プ 抵 抗		01
R0358	RD356180	Carbon Resistor (chip)	1.8K 63M J	チ ッ プ 抵 抗		01
R0359	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0360	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0361	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0362	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0363	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
-0366	RD356100	Carbon Resistor (chip)	1.0K 63M J	チ ッ プ 抵 抗		01
R0367	RD355120	Carbon Resistor (chip)	120.0 63M J	チ ッ プ 抵 抗		01
R0368	RD355120	Carbon Resistor (chip)	120.0 63M J	チ ッ プ 抵 抗		01
R0369	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0370	RD358100	Carbon Resistor (chip)	100.0K 63M J	チ ッ プ 抵 抗		01
R0371	RD357100	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01

\*: New parts

RANK: Japan only

REF NO.	PART NO.	DESCRIPTION	部 品 名	REMARKS	QTY	RANK
R0372	<b>RD357270</b>	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0373	<b>RD357270</b>	Carbon Resistor (chip)	27.0K 63M J	チ ッ プ 抵 抗		01
R0374	<b>RD357180</b>	Carbon Resistor (chip)	18.0K 63M J	チ ッ プ 抵 抗		01
R0375	<b>RD357100</b>	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0376	<b>RD357100</b>	Carbon Resistor (chip)	10.0K 63M J	チ ッ プ 抵 抗		01
R0377	<b>RD154470</b>	Carbon Resistor (chip)	47.0 1/4 J	チ ッ プ 抵 抗		01
R0378	<b>RD154470</b>	Carbon Resistor (chip)	47.0 1/4 J	チ ッ プ 抵 抗		01
R0379	<b>RD256100</b>	Carbon Resistor (chip)	1.0K 0.1 J	チ ッ プ 抵 抗		01
R0380	<b>RD256100</b>	Carbon Resistor (chip)	1.0K 0.1 J	チ ッ プ 抵 抗		01
SW301	<b>VZ085500</b>	Tact Switch	SKQNAM004A	タ ク ト S W		01
-308	<b>VZ085500</b>	Tact Switch	SKQNAM004A	タ ク ト S W		01
TR001	<b>VV556400</b>	Transistor	2SC2412K Q,R,S	ト ラ ン ジ スタ		01
TR002	<b>VV556400</b>	Transistor	2SC2412K Q,R,S	ト ラ ン ジ スタ		01
TR003	<b>VY677600</b>	Digital Transistor	DTC123JKA TP	デ ジ タ ル ト ラ ン ジ スタ		01
TR004	<b>VY677600</b>	Digital Transistor	DTC123JKA TP	デ ジ タ ル ト ラ ン ジ スタ		01
TR101	<b>VV556400</b>	Transistor	2SC2412K Q,R,S	ト ラ ン ジ スタ		01
TR102	<b>VJ927200</b>	Transistor	2SA1162 O,Y	ト ラ ン ジ スタ		01
TR301	<b>VD303700</b>	Transistor	2SC3326 A,B TE85R	ト ラ ン ジ スタ		01
-304	<b>VD303700</b>	Transistor	2SC3326 A,B TE85R	ト ラ ン ジ スタ		01
VR301	<b>VS053600</b>	Rotary Variable Resistor	A 10.0K RK09K12A	二 連 ロ ー タ リ ー V R	VOL	03
X0001	<b>V9366600</b>	Ceramic Resonator	8.4672M CSTCC8M46	セ ラ ミ ッ ク 振 動 子		03
ZD101	<b>VU172600</b>	Zener Diode	UDZS10B TE-17 10V	ツ ェ ナ ー ダイ オ ード		03
*	<b>WD559200</b>	Power Switch Assembly	L	電 源 S W A s s ' y	POWER STNDBY	02
	<b>V7054700</b>	Power Switch	SDDJE1-A-2	パ ワ ー S W		02
	<b>WD584200</b>	Connector Assembly	PSW	PSW 束 線 A s s ' y		02

\*: New parts